# MLX90374 - Triaxis® Position Processor

Datasheet

## Features and Benefits

- Tria⊗is® Hall Technology
- On Chip Signal Processing for Robust Absolute Position Sensing
- ⊘SIL READY BY MELEXIS ISO26262 ASIL-C Safety Element out of Context
- AEC-Q100 Qualified
- Programmable Measurement Range
- Programmable Linear Transfer Characteristic (4 or 8 Multi-points or 16 or 32 PWL)
- PWM Redundant Dual Output
- SENT and Programmable Switch Dual Output
- SAE J2716 APR2016 SENT
- Enhanced serial data communication
- 48 bits ID Number option
- Single Die - SOIC-8 Package (RoHS)
- PCB-less DMP-4 Package (RoHS)
- Robustness against stray-field
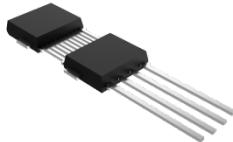
SOIC-8          DMP-4

## Application Examples

- Absolute Rotary Position Sensor
- Pedal Position Sensor
- Throttle Position Sensor
- Ride Height Position Sensor
- Absolute Linear Position Sensor
- Steering Wheel Position Sensor
- Float-Level Sensor
- Non-Contacting Potentiometer

## Description

The MLX90374 is a monolithic magnetic position processor IC. It consists of a Triaxis® Hall magnetic front end, an analog to digital signal conditioner, a DSP for advanced signal processing and a dual output stage driver.

The MLX90374 is sensitive to the three components of the magnetic flux density applied to the IC (i.e. Bx, By and Bz). This allows the MLX90374 with the correct magnetic circuit to decode the absolute position of any moving magnet (e.g. rotary position from 0 to 360 Degrees or linear displacement, see fig. 2). It enables the design of non-contacting position sensors that are frequently required for both automotive and industrial applications.

The MLX90374 provides either a dual PWM output or a combination of SENT plus a programmable switch function. In dual PWM output mode, the circuit offers a wide panel of configurations from fully redundant signals to individually configurable outputs, including the choice between several error reporting modes. In SENT mode, the circuit delivers enhanced serial messages consisting of error codes, and user-defined values.
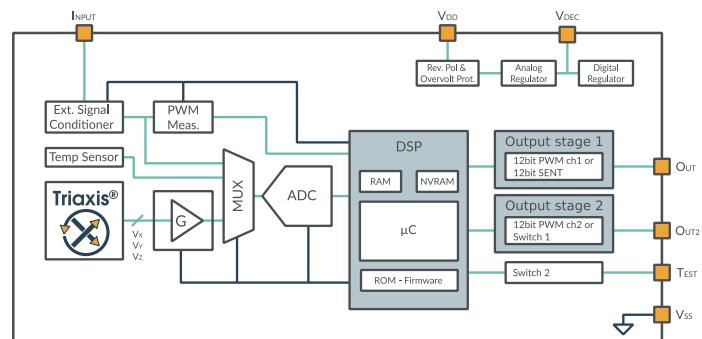
# Ordering Information

| Product | Temp. | Package | Option Code | Packing Form | Definition |
|---|---|---|---|---|---|
| MLX90374 | G | DC | ABB-200 | RE | Linear position Strayfield Immune |
| MLX90374 | G | DC | ABB-300 | RE | Angular Rotary / Linear position |
| MLX90374 | G | VS | ABB-200 | RE/RX | Linear position Strayfield Immune |
| MLX90374 | G | VS | ABB-207 | RE/RX | Linear position Strayfield Immune |
| MLX90374 | G | VS | ABB-300 | RE/RX | Angular Rotary / Linear position |
| MLX90374 | G | VS | ABB-307 | RE/RX | Angular Rotary / Linear position |
| MLX90374 | G | DC | ABC-100 | RE | Angular Rotary Strayfield Immune |
| MLX90374 | G | DC | ABC-200 | RE | Linear position Strayfield Immune |
| MLX90374 | G | DC | ABC-300 | RE | Angular Rotary / Linear position |
| MLX90374 | G | VS | ABC-100 | RE/RX | Angular Rotary Strayfield Immune |
| MLX90374 | G | VS | ABC-107 | RE/RX | Angular Rotary Strayfield Immune |
| MLX90374 | G | VS | ABC-200 | RE/RX | Linear position Strayfield Immune |
| MLX90374 | G | VS | ABC-207 | RE/RX | Linear position Strayfield Immune |
| MLX90374 | G | VS | ABC-300 | RE/RX | Angular Rotary / Linear position |
| MLX90374 | G | VS | ABC-307 | RE/RX | Angular Rotary / Linear position |

*Table 1 - Ordering Codes*

| | |
|---|---|
| **Temperature Code:** | **G: from -40°C to 160°C** |
| Package Code: | DC : SOIC-8 package (see 17.1) <br> VS : DMP-4 package (PCB-less dual mold, see 17.6) |
| Option Code - Chip revision | **ABC**-123 **: Chip Revision** <br> ▪ ABB : Not recommended for new designs [1] <br> ▪ ABC : Standard preferred revision [1] |
| Option Code - Application | ABC-**1**23 : **1**-**Application - Magnetic configuration** <br> ▪ 1: Angular Rotary Strayfield Immune <br> ▪ 2: Linear position Strayfield Immune <br> ▪ 3: Legacy / Angular Rotary / Linear position |

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*[1] ABC is preferred product revision to be selected for new designs. ABB remains in production during the entire product lifecycle but does not include all the features of the ABC revision.*

| Option Code - SW & DMP-4 configuration | ABC-**12**3: **2-SW and DMP-4 package configuration**<br>For SOIC-8 (code DC) packages<br>   ▪  0: 2x PWM / SENT 3µs mode<br>For DMP-4 (code VS) package (see section 14.2)<br>   ▪  0 : 2x PWM / SENT 3 µs mode ($C_1$, $C_4$ = 10nF) |
|---|---|
| Option Code - Trim & Form | ABC-**12**3: **3** - **DMP-4 Trim & Form configuration**<br>   ▪  0: Standard straight leads. See section 17.5<br>   ▪  7: Trim and Form STD3 2.00 See section 17.6 |
| Packing Form: | -RE : Tape & Reel<br>   ▪  VS:2500 pcs/reel<br>   ▪  DC:3000 pcs/reel<br>-RX : Tape & Reel, similar to RE with parts face-down (VS package only) |
| Ordering Example: | MLX90374GVS-ABC-307-RX<br>For a legacy version in DMP-4 package with trim and form STD3 2.00, delivered in Reel face down. |

*Table 2 - Ordering Codes Information*

# Contents

# 1. Functional Diagram and Application Modes
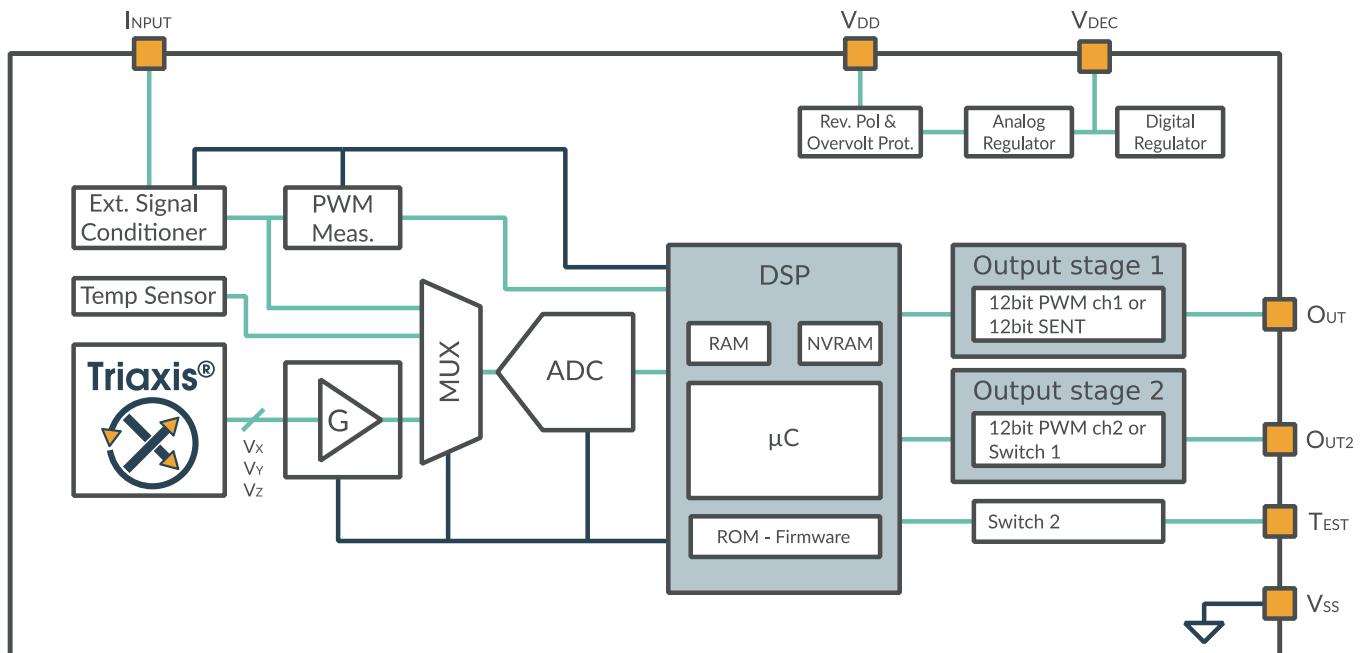


*fig. 1 - MLX93074 Block diagram*
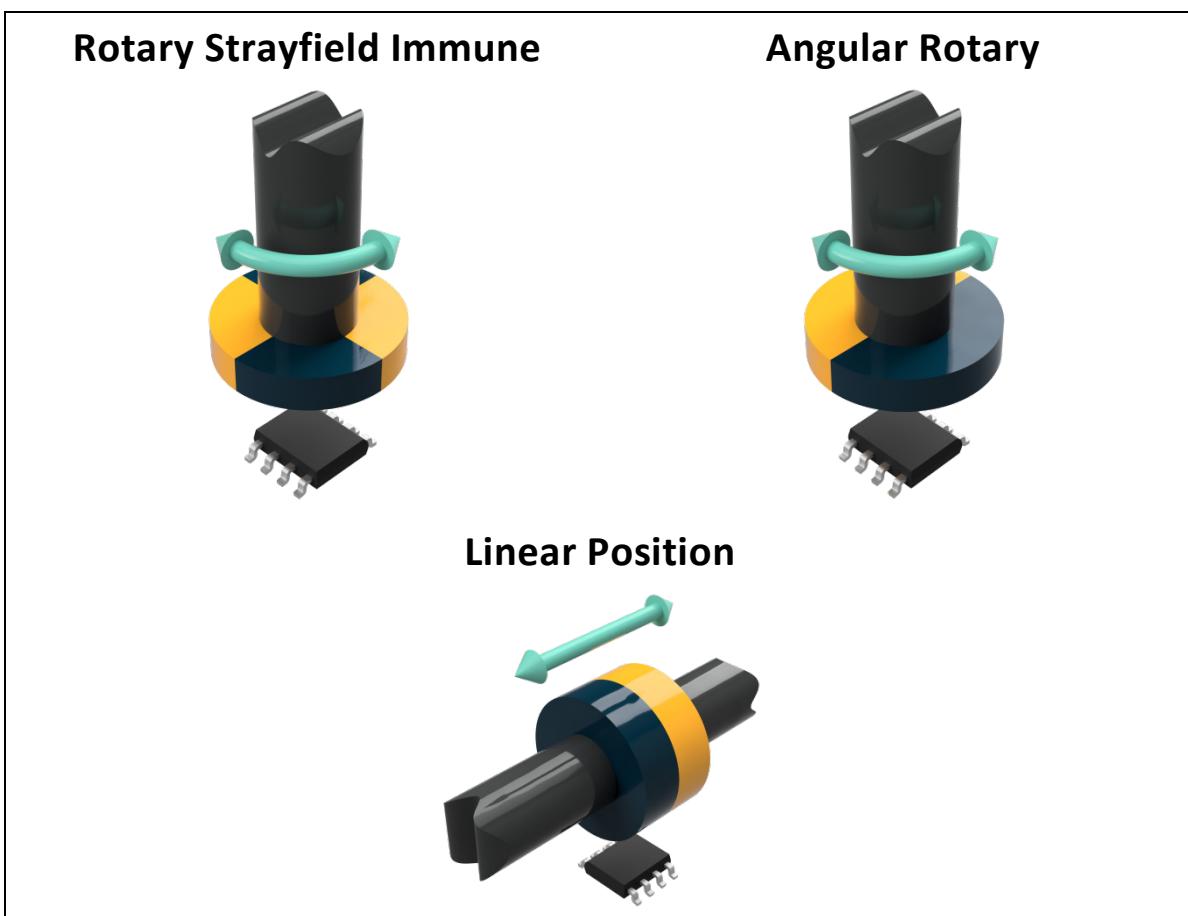


*fig. 2 - Application Modes*

# 2. Glossary of Terms

| Name | Description |
|---|---|
| ADC | Analog-to-Digital Converter |
| AoU | Assumption of Use |
| ASP | Analog Signal Processing |
| AWD | Absolute Watchdog |
| CPU | Central Processing Unit |
| CRC | Cyclic Redundancy Check |
| %DC | Duty Cycle of the output signal i.e. $T_{ON} / (T_{ON} + T_{OFF})$ |
| DMP | Dual Mold Package |
| DP | Discontinuity Point |
| DCT | Diagnostic Cycle Time |
| DSP | Digital Signal Processing |
| ECC | Error Correcting Code |
| EMA | Exponential Moving Average |
| EMC | Electro-Magnetic Compatibility |
| EoL | End of Line |
| FIR | Finite Impulse Response |
| Gauss (G) | Alternative unit for the magnetic flux density (10G = 1mT) |
| HW | Hardware |
| IMC | Integrated Magnetic Concentrator |
| INL / DNL | Integral Non-Linearity / Differential Non-Linearity |
| IWD | Intelligent Watchdog |
| LSB/MSB | Least Significant Bit / Most Significant Bit |
| NC | Not Connected |
| NVRAM | Non Volatile RAM |
| POR | Power On Reset |
| PSF | Product Specific Functions |
| PWL | Piecewise Linear |
| PWM | Pulse Width Modulation |
| RAM | Random Access Memory |
| ROM | Read-Only Memory |
| SEooC | Safety Element out of Context |
| TC | Temperature Coefficient (in ppm/°C) |
| Tesla (T) | SI derived unit for the magnetic flux density (Vs/m2) |

*Table 3 - Glossary of Terms*

# 3. Pin Definitions and Descriptions

## 3.1. Pin Definition for SOIC-8 package

| Pin # | Name | Description |
|:---:|:---:|:---:|
| 1 | $V_{DD}$ | Supply |
| 2 | Input | For test or Application |
| 3 | $OUT_2$ | Second Output |
| 4 | Test | For test or application |
| 5 | $OUT_1$ | First Output |
| 6 | $V_{SS}$ | Digital ground |
| 7 | $V_{DEC}$ | Decoupling pin |
| 8 | $V_{SS}$ | Analog ground |

*Table 4 - SOIC-8 Pins definition and description*

Pins Input and Test are internally grounded in application. For optimal EMC behaviour always connect the unused pins to the electrical ground of the PCB.

## 3.2. Pin Definition for DMP

DMP-4 package adds a dual output PCB-less solution to the Triaxis® product family.

| Pin # | Name | Description |
|:---:|:---:|:---:|
| 1 | $OUT_1$ | First Output |
| 2 | $V_{SS}$ | Ground |
| 3 | $V_{DD}$ | Supply |
| 4 | $OUT_2$ | Second Output |

*Table 5 - DMP-4 Pins definition and description*

# 4. Absolute Maximum Ratings

| Parameter | Symbol | Min | Max | Unit | Condition |
|---|---|---|---|---|---|
| Supply Voltage | $V_{DD}$ | | 27 | V | < 48h ; $T_j$ < 175°C |
| | $V_{DD}$ | | 37 | V | < 60s ; $T_{AMB}$ < 35°C |
| Reverse Voltage Protection | $V_{DD-rev}$ | -14 | | V | < 48h |
| | $V_{DD-rev}$ | -20 | | V | < 1h |
| Positive Output Voltage | $V_{OUT}$ | | 27 | V | < 48h |
| Reverse Output Voltage | $V_{OUT-rev}$ | -14 | | V | < 48h |
| Internal Voltage | $V_{DEC}$ | | 3.6 | V | |
| | $V_{DEC-rev}$ | -0.3 | | V | |
| Positive Input pin Voltage | $V_{Input}$ | | 6 | V | |
| Reverse Input pin Voltage | $V_{Input-rev}$ | -3 | | V | |
| Test pin Voltage | $V_{TEST}$ | | 3.6 | V | |
| | $V_{TEST-rev}$ | -0.3 | | V | |
| Operating Temperature | $T_{AMB}$ | -40 | +160 | °C | |
| Junction Temperature | $T_J$ | | +175 | °C | see 17.10 for package thermal dissipation values |
| Storage Temperature | $T_{ST}$ | -55 | +170 | °C | |
| Magnetic Flux Density | $B_{max}$ | -1 | 1 | T | |

*Table 6 - Absolute maximum ratings*

Exceeding the absolute maximum ratings may cause permanent damage.

Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.

# 5. General Electrical Specifications

General electrical specifications are valid for temperature range [-40;160] °C and supply voltage range [4.5;5.5] V unless otherwise noted.

| Electrical Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| Supply Voltage | $V_{DD}$ | 4.5 | 5 | 5.5 | V | For voltage regulated mode |
| Supply Voltage Battery | $V_{DD}$ | 6 | 12 | 18 | V | For Battery usage [2] |
| Supply Current | $I_{DD}$ | 9.0 | 10.5 | 12.6 | mA | Rotary and linear stray field applications (option code -100, -200) |
| Supply Current | $I_{DD}$ | 8.0 | 9.0 | 10.5 | mA | Legacy applications (option code -300) |
| Surge Current | $I_{surge}$ | - | 30 | 40 | mA | IC Startup current ($t_{startup}$ < 40µs) |
| Start-up Level | $V_{DDstart}$ | 3.6 | | | V | Minimal supply start-up voltage |
| PTC Entry Level (rising) | $V_{PROV0}$ | 7.10 | 7.35 | 7.70 | V | Supply overvoltage detection in 5V applications [2] |
| PTC Entry Level Hysteresis | $V_{PROV0Hyst}$ | 400 | 500 | 600 | mV | |
| PTC Entry Level (rising) | $V_{PROV1}$ | 21.5 | 23.0 | 24.5 | V | For Battery usage [2] |
| PTC Entry Level Hysteresis | $V_{PROV1Hyst}$ | 0.8 | 1.4 | 2.0 | V | For Battery usage [2] |
| Under voltage detection | $V_{DDUVH}$ | 3.95 | 4.10 | 4.25 | V | Supply undervoltage high threshold |
| Under voltage detection | $V_{DDUVL}$ | 3.75 | 3.90 | 4.05 | V | Supply undervoltage low threshold |
| Regulated Voltage | $V_{DEC}$ | 3.2 | 3.3 | 3.4 | V | Internal analog voltage |
| Regulated Voltage Overvoltage detection | $V_{DECOVH}$ | 3.65 | 3.75 | 3.85 | V | High threshold |
| Regulated Voltage Undervoltage detection | $V_{DECUVL}$ | 2.70 | 2.85 | 2.92 | V | Low threshold |
| Regulated Voltage UV / OV detection hysteresis | $V_{DECOVHyst}$ $V_{DECUVHyst}$ | 100 | 150 | 200 | mV | |
| Digital supply | $V_{DDD}$ | 1.80 | 1.85 | 1.95 | V | |
| Digital supply Overvoltage detection | $V_{DDDOVH}$ | 2.00 | 2.10 | 2.20 | V | |
| Digital Supply Undervoltage detection | $V_{DDDUVL}$ | 1.585 | 1.680 | 1.735 | V | Power-on Reset low threshold |
| Digital Supply OV / UV detection Hysteresis | $V_{PORHyst}$ | 30 | 100 | 200 | mV | |

*Table 7 - Supply System Electrical Specifications*

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[2] *Selection between 5V or battery applications is done using WARM_ACT_HIGH parameter. See chap.11*

| Electrical Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| Output Short Circuit Current[3] | $I_{OUTshortPP}$ | -25<br>8 | | -10<br>15 | mA<br>mA | Push-pull modes (SENT, PWM)<br>$V_{OUT}$ = 0 V<br>$V_{OUT}$ = 5 V .. 18V |
| Ouput Short Circuit Current | $I_{OUTshortOD1}$ | 10 | | 25 | mA | $V_{OUT}$ = 5V |
| Output Short Circuit Current | $I_{OUTshortOD2}$ | 40 | | 90 | mA | PWM mode Open Drain only (see 12.3.5) |
| Output Load | $R_L$ | 3 | | | kΩ | PWM pull-up to 5V,<br>PWM pull-down to 0V |
| | $R_L$ | 10 | - | 55 | kΩ | SENT pull-up |
| | $R_L$ | 1 | - | 100 | kΩ | Open drain pull-up |
| Digital push-pull output level | $V_{satLoPP}$ | 0 | 1 | 2<br>5 | %$V_{DD}$ | $R_L$ ≥ 10kΩ<br>$R_L$ ≥ 3kΩ, pull-up to 5V |
| | $V_{satHiPP}$ | 98<br>95 | 99 | 100 | %$V_{DD}$ | $R_L$ ≥ 10kΩ<br>$R_L$ ≥ 3kΩ, pull-down |
| Digital open drain output level | $V_{satLoOD}$ | 0 | | 10 | %$V_{ext}$ | Pull-up to any external voltage<br>$V_{ext}$ ≤ 18V, $I_L$ ≤ 3.4mA |
| Digital output Ron | $R_{on}$ | 27 | 50 | 100 | Ω | Push-pull mode |

*Table 8 - Output Electrical specifications*

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[3] *Output current limitation triggers after a typical delay of 3µs.*

# 6. Timing Specification

Timing specifications are valid for temperature range [-40;160] °C and supply voltage range [4.5;5.5] V unless otherwise noted.

## 6.1. General Timing Specifications

| Parameter | Symbol | Min. | Typ | Max. | Unit | Condition |
|---|---|---|---|---|---|---|
| Main Clock Frequency | $F_{CK}$ | 22.8 | 24 | 25.2 | MHz | Including thermal and lifetime drift |
| | | -5 | | 5 | $\%F_{ck}$ | Relative tolerances, including thermal and lifetime drift |
| Main Clock initial tolerances | $\Delta F_{CK,0}$ | 23.75 | 24 | 24.25 | MHz | T=35°C |
| Main Clock Frequency Thermal Drift | $\Delta F_{CK,T}$ | -2 | - | 2 | $\%F_{ck}$ | Relative to clock frequency at 35°C. No ageing effects. |
| 1MHz Clock Frequency | $F_{1M}$ | | 1 | | MHz | |
| Intelligent Watchdog Timeout | $T_{IWD}$ | 19 | 20 | 21 | ms | $F_{CK}$ = 24MHz |
| Absolute Watchdog Timeout | $T_{AWD}$ | 19 | 20 | 21 | ms | $F_{1M}$ = 1MHz |
| Analog Diagnostics DCT | $DCT_{ANA}$ | 34 | | 34 | $T_{angleMeas}$ | PWM or SENT Asynchronous mode (6.2.1) |
| | | 17 | | 17 | $T_{frame}$ | SENT Sync. Mode, $N_{angFram}=2$ |
| | | 34 | | 34 | $T_{frame}$ | SENT Sync. Mode, $N_{angFram}=1$ |
| Digital Diagnostics DCT | $DCT_{DIG}$ | | | 20 | ms | see Table 67, section 13.2 |
| Fail Safe state duration | $T_{FSS}$ | 9.8 | 11.0 | 11.9 | ms | After a digital single-event fault ABC revision |
| | | 28.4 | 32.0 | 34.6 | | ABB revision |
| Safe Startup Time | $T_{SafeStup}$ | - | 11.2 | 12.4 | ms | Only valid for ABC revision (see 6.3.1.2) |

*Table 9 - General Timing Specifications*

## 6.2. Timing Modes

The MLX90374 can be configured in two continuous angle acquisition modes described in the following sections.

### 6.2.1. Continuous Asynchronous Acquisition Mode

In this mode, the sensor continuously acquire angle at a fixed rate that is asynchronous with regards to the output. The acquisition rate is defined by the variable T_ADC_SEQ parameter which defines the angle measurement period $T_{angleMeas}$. This mode is used in PWM and SENT without pause. Even though PWM is periodic, asynchronous mode is better suited and enables complete filtering options for PWM signals that are often slow compared to the sensor internal measurement sequence.
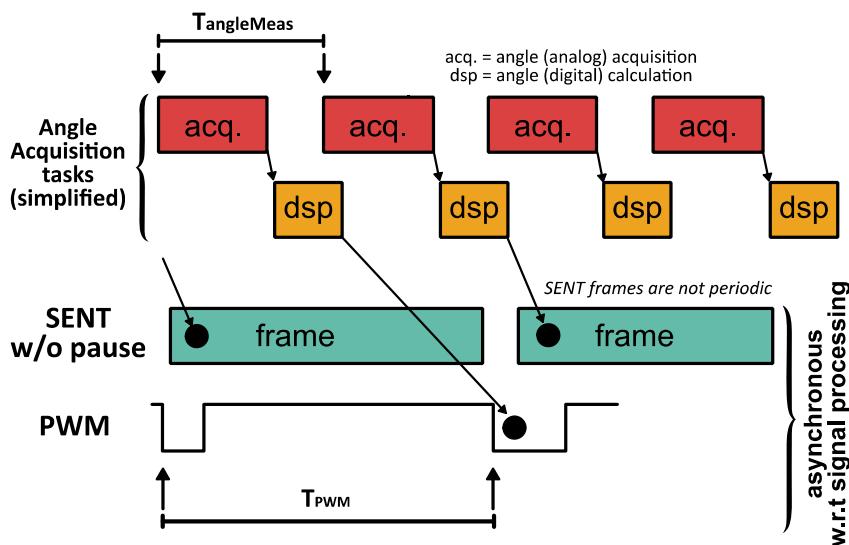
*fig. 3 - Continuous Asynchronous Timing Mode*

| Parameter | Symbol | Min. | Typ | Max. | Unit | Condition |
|-----------|--------|------|-----|------|------|-----------|
| Angle acquisition time | $T_{angleAcq}$ | | 330 | | µs | |
| Internal Angle Measurement Period | $T_{angleMeas}$ | 528 | 588 | - | µs | Typical is default factory settings (no user control) |
| SENT Frame Tick Count | $N_{Tframe}$ | 282 | - | - | ticks | **Do not modify** for asynchronous mode (see chap.11, T_FRAME) |

*Table 10 - Continuous Asynchronous Timing Mode*

## 6.2.2. Continuous Synchronous Acquisition Mode

In continuous synchronous timing mode, the sensor acquires angles based on the output frequency. As a consequence, the output should have a fixed frame frequency. This mode is used only with constant SENT frame length (SENT with pause). The length of the SENT frame is defined by the parameter T_FRAME in number of ticks. The user has the choice to select either one or two angle acquisitions and DSP calculations per frame.
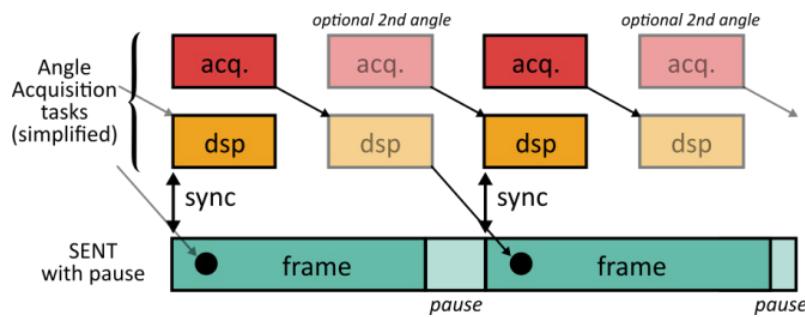


*fig. 4 - Continuous Synchronous Timing Mode*

Following table describes the frame length of synchronous acquisition mode with regards to T_FRAME parameter value (see chap. 11). Minimal values represent MLX90374 best achievable performance. Typical values are default or recommended values. Maximal values are limited by the SAE J2716 standard and not displayed in this table. For a chosen timing configuration, one has to consider the main clock relative tolerances listed in Table 9 to get a tolerance on the frame duration.

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| SENT Frame Tick Count (Normal SENT) | $N_{Tframe}$ | 310[4] | 320 | - | ticks | For tick time of 3µs (Normal SENT) and two angles per frame |
| SENT Frame Tick Count (Normal SENT) | $N_{Tframe}$ | 282[4] | 304[5] | - | ticks | For tick time of 3µs (Normal SENT) and one angle per frame |
| SENT Frame Tick Count (Fast SENT) | $N_{Tframe}$ | 320[4] | 330 | - | ticks | For tick time of 1.5µs (Fast SENT) and one angle per frame |
| SENT Frame Period (Normal SENT) | $T_{frame}$ | 930[4] | 960 | - | µs | 3µs tick time with pause and two angles per frame ($F_{CK}$ = 24MHz) |
| SENT Frame Period (Fast) | $T_{frame}$ | 480[4] | 495 | - | µs | 1.5µs tick time with pause, one angle per frame ($F_{CK}$ = 24MHz) |
| Number of angles per frame | $N_{angFram}$ | 1 | 2 | | | set by TWO_ANGLE_FRAME parameter |

*Table 11 - SENT Synchronous Timing Mode Configuration*

## 6.3. Timing Definitions

### 6.3.1. Startup Time
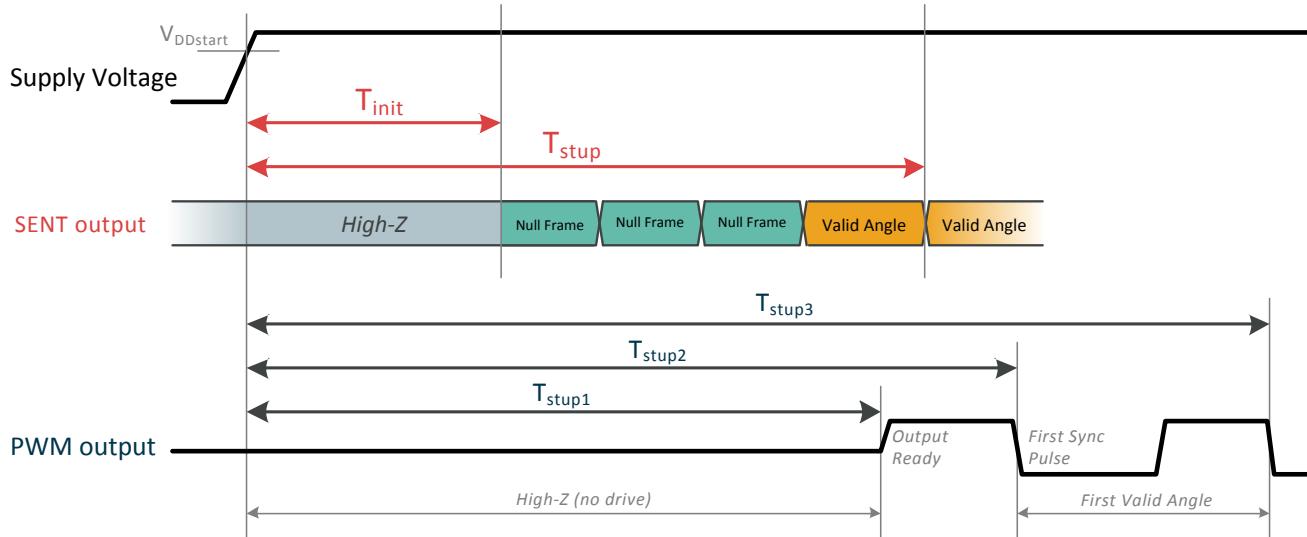


*fig. 5 - Startup Time Definition*

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[4] *Minimal timings are only confirmed to work in a specific configuration and may lead to noise degradation. Melexis recommends typical configuration (factory settings) for safe operation with any end user configuration.*

[5] *This timing optimizes the startup time (see Table 14)*

### 6.3.1.1. Normal Startup

A typical startup in SENT consists of two main phases. During the first one, the circuit performs its initialisation until being able to start acquiring angles and transmitting SENT frames. This first phase lasts $T_{init}$ milliseconds. After that time, the IC starts transmitting SENT initialisation frames, also called null frames, their content being mainly zeros. During the second phase, the sensor acquires angles until the amplification chain gain settles. The overall startup time $T_{stup}$ is the time between power up and complete transmission of the first valid angle.

### 6.3.1.2. Safe Startup

When COLD_SAFE_STARTUP_EN is set (see chap.11, End-User Programmable Items), the circuit performs a full diagnostic cycle before starting the transmission of an angle. This sequence lasts $T_{SafeStup}$ milliseconds (see Table 9 - General Timing Specifications). After $T_{init}$, the circuit start sending null SENT frames until the full diagnostic sequence is complete.

### 6.3.1.3. Startup phase in PWM mode

In PWM mode, startup is defined by three values, $T_{stup[1..3]}$. The first value is reached when the output is ready and starts to drive a voltage. The second value $T_2$ is the start of the first value angle transmission and the third one $T_3$ the moment the first angle has been transmitted.

## 6.3.2. Latency (average)

Latency is the average lag between the movement of the detected object (magnet) and the response of the sensor output. This value is representative of the time constant of the system for regulation calculations.
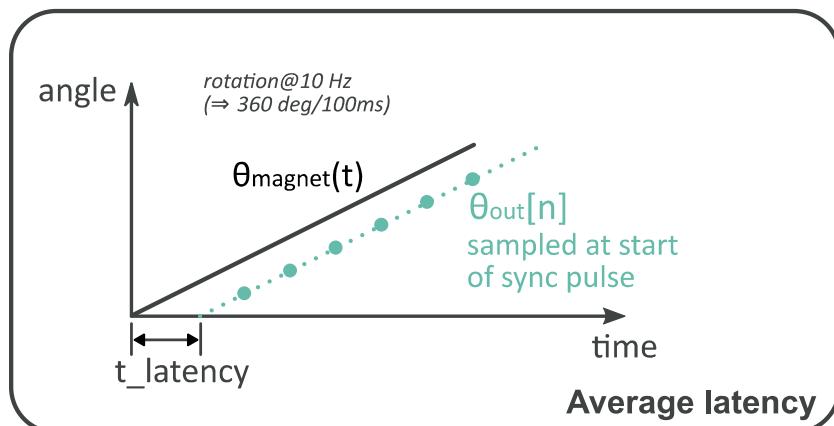


*fig. 6 - Definition of Latency*

## 6.3.3. Step Response (worst case)

Step response is defined as the delay between a change of position of the magnet and the 100% settling time of the sensor output with full angle accuracy with regards to filtering. Worst case is happening when

the movement of the magnet occurs just after a measurement sequence has begun. Step response therefore consists of the sum of:

- $\delta_{mag,measSeq}$, the delay between magnetic change and start of next measurement sequence
- $T_{measSeq}$, the measurement sequence length
- $\delta_{measSeq,frameStart}$, the delay between end of measurement sequence and start of next frame
- $T_{frame}$, the frame length

For worst case, the measurement sequence length is considered for $\delta_{mag,measSeq}$. This gives:

$$T_{wcStep} = 2T_{measSeq} + \delta_{measSeq,frameStart} + T_{frame}$$
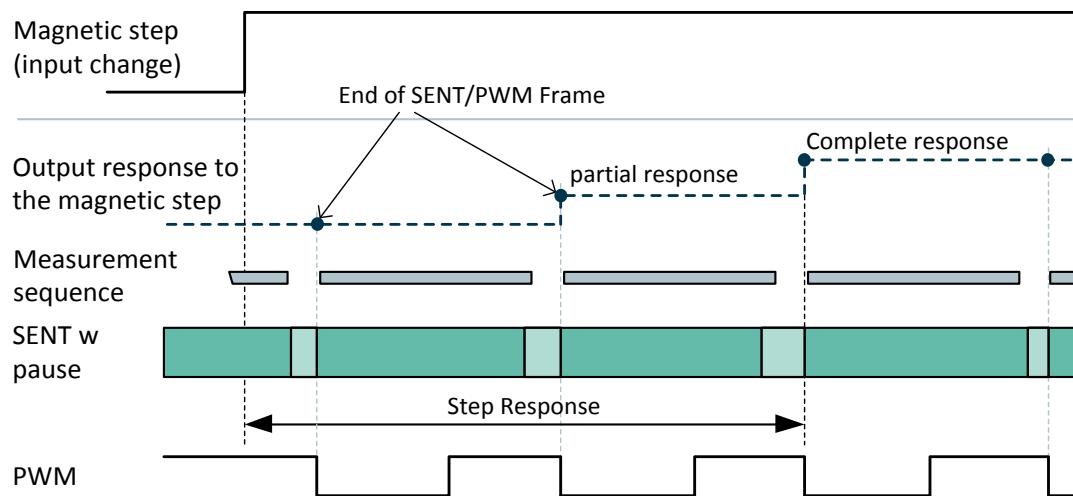


*fig. 7 - Step Response Definition*

## 6.4. PWM timing specifications

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| PWM Frequency | $F_{PWM}$ | 100 | 1000 | 2000 | Hz | |
| PWM Frequency Initial Tolerances | $\Delta F_{PWM,0}$ | -1.5 | | 1.5 | $\%F_{PWM}$ | T=35°C, can be trimmed at EOL |
| PWM Frequency Thermal Drift | $\Delta F_{PWM,T}$ | -2.0 | | 2.0 | $\%F_{PWM}$ | |
| PWM Frequency Drift | $\Delta F_{PWM}$ | -5.0 | | 5.0 | $\%F_{PWM}$ | Over temperature and lifetime |
| PWM startup Time (up to output ready) | $T_{stup1}$ | | 6.60 | | ms | |
| PWM startup Time (up to first sync. Edge) | $T_{stup2}$ | 7.10 | 7.60 | 16.6 | ms | $T_{stup1} + T_{PWM}$ |

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| PWM startup Time (up to first data received) | $T_{stup3}$ | 7.60 | 8.60 | 26.6 | ms | $T_{stup1} + 2* T_{PWM}$ [6] |
| Rise Time PWM | $t_{rise}$ | 1.0 | 4.8 | 12.0 | µs | typ. with SENT_SEL_SR_RISE/FALL = 4 (see 10.2.6). Measured between 1.1V and 3.8V |
| Fall Time PWM | $t_{fall}$ | 1.0 | 4.8 | 12.0 | µs | |

*Table 12 - PWM timing specifications*

## 6.5. SENT timing specifications

Timing specifications are valid for a given configuration of the SENT frame and tick time (see 10.2.9).

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| Tick time | | 1.5 | 3 | 6 | µs | 1.5µs = Fast SENT<br>3µs = Normal SENT (default)<br>6µs = Slow SENT |
| SENT startup time (up to first sync pulse) | $T_{init}$ | - | 2.95 | 3.10 | ms | Until initialisation frame starts |
| SENT edge rise Time | | 4.5 | 6.2 | 7.5 | µs | for SENT_SEL_SR_RISE/FALL =4 (see 10.2.6) |
| SENT edge fall Time | | 3.9 | 4.8 | 5.2 | µs | |
| Slow Message cycle length | | | 691<br>415 | | ms | Extended sequence ( 40 frames )<br>Short sequence (24 frames ) |

*Table 13 - SENT General Timing Specifications*

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| **For SENT with pause (synchronous), 3µs tick time, 2 angles per SENT frame, T_FRAME = 310** | | | | | | |
| SENT startup time | $T_{stup}$ | - | 6.48 | - | ms | Until first valid angle received |
| Average Latency | $T_{latcy}$ | - | 1.73<br>2.19 | - | ms | Filter = 1 (FIR11)<br>Filter = 2 (FIR1111) [7] |
| Step Response (worst case) | $T_{wcStep}$ | - | - | 2.98<br>3.91 | ms | Filter = 1 (FIR11)<br>Filter = 2 (FIR1111) [7] |
| **For SENT with pause (synchronous), 3µs tick time, 2 angles per SENT frame, T_FRAME = 320** | | | | | | |
| SENT startup time | $T_{stup}$ | - | 6.60 | - | ms | Until first valid angle received |
| Average Latency | $T_{latcy}$ | - | 1.77<br>2.25 | - | ms | Filter = 1 (FIR11)<br>Filter = 2 (FIR1111) [7] |
| Step Response (worst case) | $T_{wcStep}$ | - | - | 3.12<br>4.08 | ms | Filter = 1 (FIR11)<br>Filter = 2 (FIR1111) [7] |

[6] *First frame transmitted has no synchronization edge; therefore the second frame transmitted is the first complete one.*

[7] *See section 12.2.3 for details concerning Filter parameter*

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| **For SENT with pause (synchronous), 3µs tick time, 1 angle per SENT frame, T_FRAME = 282** | | | | | | |
| SENT startup time | $T_{stup}$ | - | 6.99 | - | ms | Until first valid angle received |
| Average Latency | $T_{latcy}$ | - | 1.33 | - | ms | Filter = 0 (no filter) |
| Step Response (worst case) | $T_{wcStep}$ | - | - | 2.32 | ms | Filter = 0 (no filter) |
| **For SENT with pause (synchronous), 3µs tick time, 1 angle per SENT frame, T_FRAME = 304** | | | | | | |
| SENT startup time | $T_{stup}$ | - | 6.41 | - | ms | Until first valid angle received |
| Average Latency | $T_{latcy}$ | - | 1.54 | - | ms | Filter = 0 (no filter) |
| Step Response (worst case) | $T_{wcStep}$ | - | - | 2.60 | ms | Filter = 0 (no filter) |

*Table 14 - Synchronous SENT Mode Timing Specifications for 3us tick time*

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| **For SENT with pause (synchronous), 1.5µs tick time, 1 angle per SENT frame, T_FRAME = 320** | | | | | | |
| SENT startup time | $T_{stup}$ | 6.12 | 6.23 | - | ms | Until first valid angle received |
| Average Latency | $T_{latcy}$ | - | 0.98<br>1.15<br>1.31 | - | ms | Filter = 0 (no filter)<br>Filter = 1 (FIR11)<br>Filter = 2 (FIR1111) [7] |
| Step Response (worst case) | $T_{wcStep}$ | - | - | 1.58<br>1.89<br>2.20 | ms | Filter = 0 (no filter)<br>Filter = 1 (FIR11)<br>Filter = 2 (FIR1111) [7] |
| **For SENT with pause (synchronous), 1.5µs tick time, 1 angle per SENT frame, T_FRAME = 330** | | | | | | |
| SENT startup time | $T_{stup}$ | 6.12 | 6.23 | - | ms | Until first valid angle received |
| Average Latency | $T_{latcy}$ | - | 1.05<br>1.21<br>1.37 | - | ms | Filter = 0 (no filter)<br>Filter = 1 (FIR11)<br>Filter = 2 (FIR1111) [7] |
| Step Response (worst case) | $T_{wcStep}$ | - | - | 1.63<br>1.95<br>2.27 | ms | Filter = 0 (no filter)<br>Filter = 1 (FIR11)<br>Filter = 2 (FIR1111) [7] |

*Table 15 - Synchronous SENT Mode Timing Specifications for 1.5us tick time*

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| **For SENT without pause (asynchronous), 3μs tick time[8]** |
| SENT startup time | $T_{stup}$ | 6.25 6.42 | 6.39 6.56 | 6.51 6.68 | ms | Until first valid angle received with SENT_INIT_GM = 1 |
| Average Latency | $T_{latcy}$ | 1.40 1.67 2.20 | 1.40 1.70 2.30 | - | ms | Filter = 0 (no filter) Filter = 1 (FIR11) Filter = 2 (FIR1111) [7] |
| Step Response (worst case) | $T_{wcStep}$ | - | 2.76 3.29 4.35 | 2.83 3.43 4.63 | ms | Filter = 0 (no filter) Filter = 1 (FIR11) Filter = 2 (FIR1111) [7] |
| **For SENT without pause (asynchronous), 1.5μs tick time[8]** |
| SENT startup time | $T_{stup}$ | 6.42 | 6.50 | 6.56 | ms | Until first valid angle received |
| Average Latency | $T_{latcy}$ | 0.91 1.17 1.70 | 0.91 1.21 1.81 | - | ms | Filter = 0 (no filter) Filter = 1 (FIR11) Filter = 2 (FIR1111) [7] |
| Step Response (worst case) | $T_{wcStep}$ | - | 1.71 2.19 3.15 | 2.01 2.61 3.81 | ms | Filter = 0 (no filter) Filter = 1 (FIR11) Filter = 2 (FIR1111) [7] |

*Table 16 - Asynchronous SENT Mode Timing Specifications*

---

[8] *In asynchronous mode, the latency is defined as an average delay with regards to all possible variations. For worst case, refer to step response (worst case) values*

# 7. Magnetic Field Specifications

Magnetic Field specifications are valid for temperature range [-40;160] °C unless otherwise noted.

## 7.1. Rotary Stray-field Immune Mode (-100 code)

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| Number of magnetic poles | $N_P$ | $4^{(9)}$ | - | - | | |
| Magnetic Flux Density in X-Y plane | $B_X$, $B_Y$ [10] | | | $25^{(11)}$ | mT | $\sqrt{B_X^2 + B_Y^2}$ (this is not the useful signal) |
| Magnetic Flux Density in Z | $B_Z$ | | | 100 | mT | (this is not the useful signal) |
| Magnetic in-plane gradient of in-plane field component | $\frac{\Delta B_{XY}}{\Delta XY}$ | 3.8 | 10 | | $\frac{mT}{mm}$ | $\frac{1}{2}\sqrt{\left(\frac{dB_X}{dX} - \frac{dB_Y}{dY}\right)^2 + \left(\frac{dB_X}{dY} + \frac{dB_Y}{dX}\right)^2}$ this is the useful signal (see fig. 8) |
| Magnet Temperature Coefficient | $TC_m$ | -2400 | | 0 | $\frac{ppm}{°C}$ | |
| Field Strength Resolution[12] | $\frac{\Delta B_{XY}}{\Delta XY}$ | 0.075 | 0.1 | 0.125 | $\frac{mT}{mm\ LSB}$ | Magnetic field gradient norm (12bits data) |
| Field too Low Threshold[13] | $B_{TH\_LOW}$ | 0.8 | 1.2 | [14] | $\frac{mT}{mm}$ | Typ is recommended value to be set by user |
| Field too High Threshold[13] | $B_{TH\_HIGH}$ | 70 | $100^{(15)}$ | $102^{(15)}$ | $\frac{mT}{mm}$ | Typ is recommended value to be set by user |

*Table 17 - Magnetic specification for rotary stray-field immune*

Nominal performances apply when the useful signal $\Delta B_{XY}/\Delta XY$ is above the typical specified limit. Under this value, limited performances apply. See 8.2 for accuracy specifications.

---

[9] *Due to 4 poles magnet usage, maximum angle measurement range is limited to 180°*

[10] *The condition must be fulfilled for all combinations of Bx and By.*

[11] *Above this limit, the IMC® starts to saturate, yielding to an increase of the linearity error.*

[12] *Only valid with default MAGNET_SREL_T[1..7] configuration*

[13] *Typ. value is set by default for NVRAM rev.9 and shall be set by user for rev.8 (see Table 43, USER_ID1 and Table 42)*

[14] *Higher values of Field too Low threshold are not recommended by Melexis and shall only been set in accordance with the magnetic design and taking a sufficient safety margin to prevent false positive.*

[15] *Due to the saturation effect of the IMC, the FieldTooHigh monitor detects only defects in the sensors*
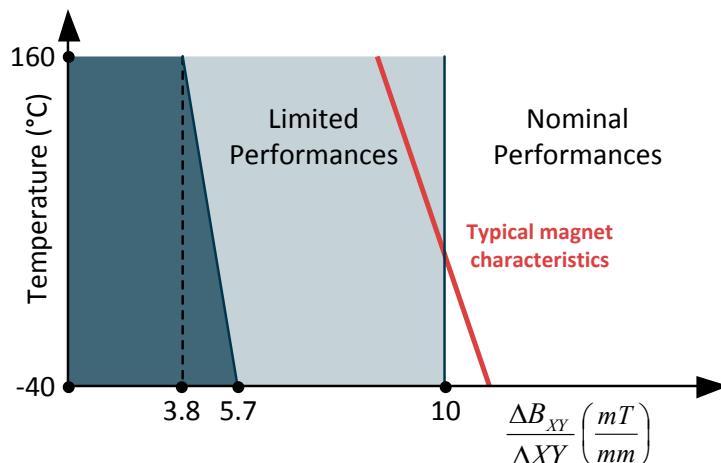
*fig. 8 - Minimum useful signal definition for rotary stray-field immune application*

## 7.2. Linear Stray-field Immune (-200 code)

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| Number of magnetic poles | $N_P$ | | 2 | - | | Linear movement |
| Magnetic Flux Density in X | $B_X$ | | | $80^{(16)}$ | mT | $B_Y \leq 20mT$ |
| Magnetic Flux Density in X-Y | $B_X, B_Y$ [17] | | | $70^{(18)}$ | mT | $\sqrt{B_X^2 + B_Y^2}$, $B_Y > 20mT$ |
| Magnetic Flux Density in Z | $B_Z$ | | | 100 | mT | |
| Magnetic gradient of X-Z field components | $\frac{\Delta B_{XZ}}{\Delta X}$ | 3 | $6^{(19)}$ | | $\frac{mT}{mm}$ | $\sqrt{\left(\frac{\Delta B_X}{\Delta X}\right)^2 + \left(\frac{1}{G_{IMC}}\frac{\Delta B_Z}{\Delta X}\right)^2}$ [20] |
| Distance between the two IMC® | $\Delta X$ | | 1.91 | | mm | see chapter 17 for magnetic center definitions |
| IMC gain | $G_{IMC}$ | | 1.19 | | | see [20] |
| Magnet Temperature Coefficient | $TC_m$ | -2400 | | 0 | $\frac{ppm}{°C}$ | |
| Field Strength Resolution[12] | $\frac{\Delta B_{XZ}}{\Delta X}$ | 0.037 | 0.05 | 0.063 | $\frac{mT}{mm\ LSB}$ | Magnetic field gradient norm expressed in 12bits words |
| Field too Low Threshold[13] | $B_{TH\_LOW}$ | 0.2 | 1.2 | [21] | $\frac{mT}{mm}$ | Typ is recommended value to be set by user |
| Field too High Threshold[13] | $B_{TH\_HIGH}$ | 35 | 50 | 51 | $\frac{mT}{mm}$ | Typ is recommended value to be set by user |

*Table 18 - Magnetic specifications for linear stray-field application*

---

[16] *Above 80 mT, with BY field in the mentioned limits, the IMC® starts saturating yielding to an increase of the linearity error.*

[17] *The condition must be fulfilled for all combinations of BX and BY.*

[18] *Above 70 mT, the IMC® starts saturating yielding to an increase of the linearity error.*

[19] *Below 6 mT/mm, the performances are degraded due to a reduction of the signal-to-noise ratio, signal-to-offset ratio.*

[20] *IMC has better performance for concentrating in-plane (X-Y) field components, resulting in a better magnetic sensitivity. A correction factor, called IMC gain has to be applied to the Z field component to account for this difference.*

[21] *Higher values of Field too Low threshold are not recommended by Melexis and shall only been set in accordance with the magnetic design and taking a sufficient safety margin to prevent false positive.*

Nominal performances apply when the useful signal ΔBxz/ΔX and temperature range are inside the values defined in the following figure (fig. 9). At higher temperature or lower field gradients, the accuracy of MLX90374 is degraded and Limited Performances, described in section 8.3.2, apply.
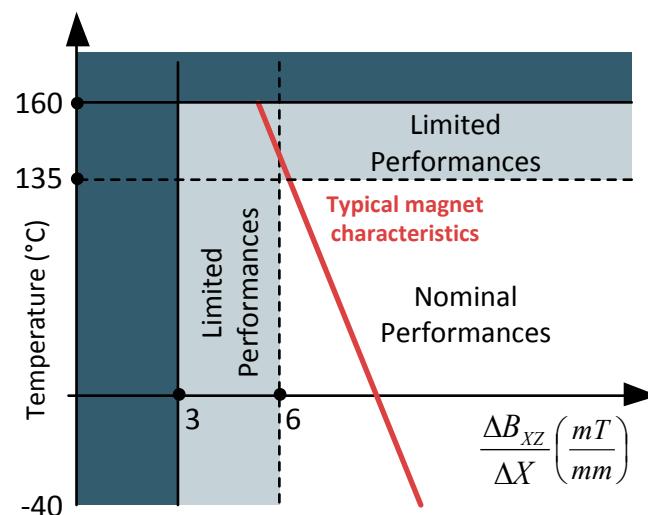


*fig. 9 - Minimum useful signal definition for linear stray-field immune application*

## 7.3. Standard/Legacy Mode (-300 code)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Condition |
|---|---|---|---|---|---|---|
| Number of magnetic poles | $N_P$ | - | 2 | - | | |
| Magnetic Flux Density in X-Y plane | $B_X$, $B_Y$ [17] | | | 70 | mT | $\sqrt{B_X^2 + B_Y^2}$ |
| Magnetic Flux Density in Z | $B_Z$ | | | 100 | mT | in absolute value |
| Useful Magnetic Flux Density Norm | $B_{Norm}$ | 10 [22] | 20 | | mT | $\sqrt{B_X^2 + B_Y^2}$ (X-y mode) <br> $\sqrt{B_X^2 + \left(\frac{1}{G_{IMC}} B_Z\right)^2}$ (X-Z mode) <br> $\sqrt{B_Y^2 + \left(\frac{1}{G_{IMC}} B_Z\right)^2}$ (Y-Z mode) <br> see 12.1.1 for sensing mode description. |
| IMC gain | $G_{IMC}$ | | 1.19 | | | see [23] |
| Magnet Temperature Coefficient | $TC_m$ | -2400 | | 0 | $\frac{ppm}{°C}$ | |

[22] *Below 10 mT the performances are degraded due to a reduction of the signal-to-noise ratio, signal-to-offset ratio*

[23] *IMC has better performance for concentrating in-plane (X-Y) field components, resulting in a better overall magnetic sensitivity. A correction factor, called IMC gain has to be applied to the Z field component to account for this difference.*

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Condition |
|---|---|---|---|---|---|---|
| Field Strength Resolution[24] | $B_{Norm}$ | 0.075 | 0.100 | 0.125 | $\dfrac{mT}{LSB}$ | Magnetic field gradient norm expressed in 12bits words |
| Field Too Low Threshold[25] | $B_{TH\_LOW}$ | 0.4 | 4.0 | [26] | mT | Typ is recommended value to be set by user |
| Field Too High Threshold[25] | $B_{TH\_HIGH}$ | 70 | 100[27] | 100[27] | mT | Typ is recommended value to be set by user |

*Table 19 - Magnetic specifications for Standard application*

Nominal performances apply when the useful signal $B_{Norm}$ is above the typical specified limit. Under this value, limited performances apply. See 8.4 for accuracy specifications.
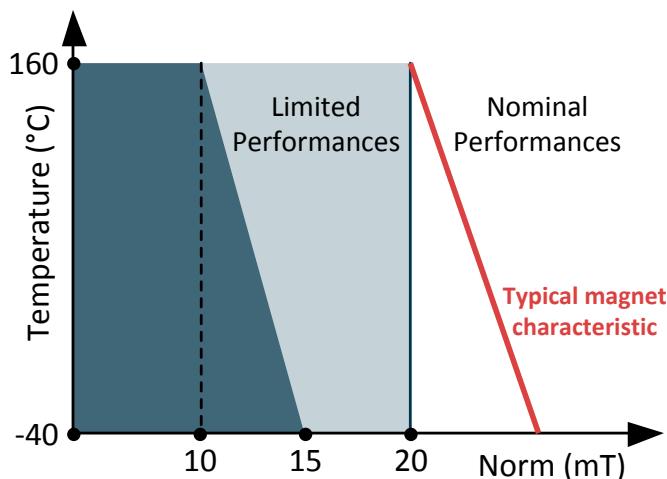


*fig. 10 - Minimum useful signal definition for Standard/Legacy application*

---

[24] *Only valid with default MAGNET_SREL_T[1..7] configuration*

[25] *Typ. value is set by default for NVRAM rev.9 and shall be set by user for rev.8 (see Table 43, USER_ID1 and Table 42)*

[26] *Higher values of Field too Low threshold are not recommended by Melexis and shall only been set in accordance with the magnetic design and taking a sufficient safety margin to prevent false positive.*

[27] *Due to the saturation effect of the IMC, the FieldTooHigh monitor detects only defects in the sensors*

# 8. Accuracy Specifications

Accuracy specifications are valid for temperature range [-40;160] °C and supply voltage range [4.5 - 5.5] V unless otherwise noted.

## 8.1. Definition

This section defines several parameters, which will be used for the magnetic specifications.

### 8.1.1. Intrinsic Linearity Error
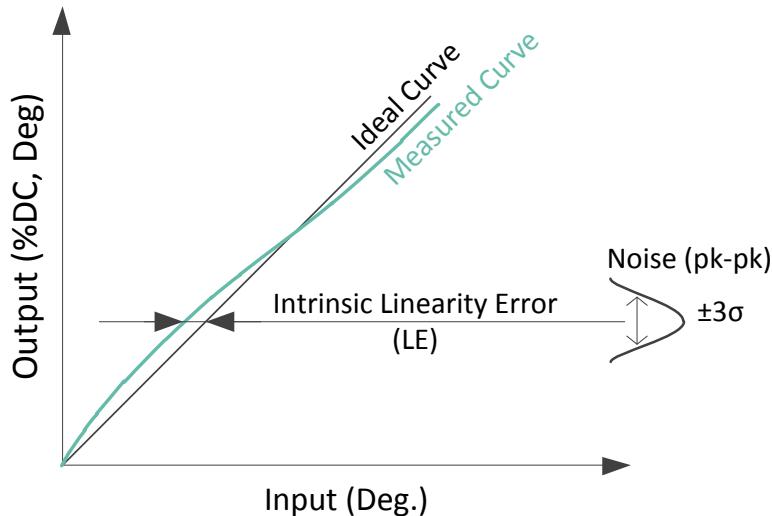


*fig. 11 - Sensor accuracy definition*

Illustration of fig. 11 depicts the intrinsic linearity error in new parts. The Intrinsic Linearity Error refers to the IC itself (offset, sensitivity mismatch, orthogonality) taking into account an ideal magnetic field. Once associated to a practical magnetic construction and the associated mechanical and magnetic tolerances, the output linearity error increases. However, it can be improved with the multi-point end-user calibration (see 12.2.6). As a consequence, this error is not critical in application because it is calibrated away.

### 8.1.2. Total Angle Drift

After calibration, the output angle of the sensor might still change due to temperature change, aging, etc. This is defined as the total drift $\partial\theta_{TT}$ :

$$\partial\theta_{TT} = \max\{\theta(\theta_{IN}, T, t) - \theta(\theta_{IN}, T_{RT}, t_0)\}$$

where $\theta_{IN}$ is the input angle, $T$ is the temperature, $T_{RT}$ is the room temperature, and $t$ is the elapsed lifetime after calibration. $t_0$ represents the status at the start of the operating life. Note the total drift $\partial\theta_{TT}$ is always defined with respect to angle at room temperature. In this datasheet, $T_{RT}$ is typically defined at 35°C, unless stated otherwise. The total drift is valid for all angles along the full mechanical stroke.

## 8.2. Rotary Stray-field Immune (-100 code)

### 8.2.1. Nominal Performance

Valid before EoL calibration and for all applications under nominal performances conditions described in section 7.1 (fig. 8) and chapter 5.

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| XY - Intrinsic Linearity Error | $L_{E\_XY}$ | -1 | | 1 | Deg. | |
| Noise [28] | | | | 0.2 | Deg. | Filter = 2 |
| | | | | 0.4 | | Filter = 0 [29] |
| XY - Total Drift [30] | $\partial\theta_{TT\_XY}$ | -0.85 | | 0.85 | Deg. | Relative to 35°C |
| Hysteresis | | | 0.1 | | Deg. | |
| Output Stray Field Immunity | $\partial\theta_{FF}$ | | | 0.6 | Deg. | with 10mT/mm useful gradient field and 4kA/m stray-field [31] |

*Table 20 - Rotary stray-field immune magnetic performances*

### 8.2.2. Limited Performances

Valid before EoL calibration and for all applications under limited performances conditions described in section 7.1 (fig. 8) and chapter 5.

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| XY - Intrinsic Maximum Error | $L_E$ | -1 | | 1 | Deg. | |
| Noise [28] | | | | 0.7 | Deg. | Filter = 0 |
| | | | | 0.5 | | Filter = 1 |
| | | | | 0.35 | | Filter = 2 |
| XY - Total Drift [30] | | -0.85 | | 0.85 | Deg. | Relative to 35°C |
| Hysteresis | | | 0.1 | | Deg. | |

*Table 21 - Rotary stray-field immune limited magnetic performances*

---

[28] $\pm 3\sigma$

[29] See section 12.2.3 for details concerning Filter parameter

[30] Verification done on new and aged devices in an ideal magnetic field gradient (see 8.1.2). An additional application-specific error arises from the non-ideal magnet and mechanical tolerance drift.

[31] Tested in accordance with ISO 11452-8:2015, at 30°C, with stray-field strength of 4kA/m from any direction. This error scales linearly with both the useful field and the disturbing field.

## 8.3. Linear Stray-field Immune Mode (-200 code)

### 8.3.1. Nominal Performances

Valid before EoL calibration and for all applications under nominal conditions described in section 7.2 (fig. 9) and chapter 5.

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| XZ - Intrinsic Maximum Error | $L_{E\_XZ}$ | -2.5 | $\pm1.25$ | 2.5 | Deg. | |
| Noise [28] | | | 0.10 | 0.20 | | Filter = 1, 6mT/mm |
| | | | 0.15 | 0.30 | Deg. | Filter = 0, 6mT/mm |
| | | | - | 0.25 | | Filter = 0, 6mT/mm, $T_{max}$=125°C |
| XZ - Total Drift [30] | $\partial\theta_{TT\_XZ}$ | -0.8 | | 0.8 | Deg. | Compared to 35°C, 6mT/mm gradient field |
| Hysteresis | | | | 0.10 | Deg. | |
| Output Stray Field Immunity | $\partial\theta_{FF}$ | | | 0.8 | Deg. | For 6mT/mm gradient field and 4kA/m stray-field [31] |

*Table 22 - Linear stray-field immune magnetic performances*

### 8.3.2. Limited Performances

Valid before EoL calibration and for all applications under limited performances conditions described in section 7.2 (fig. 9) and chapter 5.

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| XZ - Intrinsic Maximum Error | $L_E$ | -4 | $\pm2$ | 4 | Deg. | |
| Noise [28] | | | 0.20 | 0.40 | | Filter = 1, 3mT/mm |
| | | | 0.25 | 0.65 | Deg. | Filter = 0, 3mT/mm |
| | | | - | 0.45 | | Filter = 0, 3mT/mm, $T_{max}$=125°C |
| XZ - Total Drift [30] | $\partial\theta_{TT\_XZ}$ | -1.4 | | 1.4 | Deg. | Compared to 35°C, 3mT/mm |
| Hysteresis | | | | 0.25 | Deg. | 3mT/mm |

*Table 23 - Linear stray-field immune limited magnetic performances*

## 8.4. Standard/Legacy Mode (-300 code)

### 8.4.1. Nominal Performances

Valid before EoL calibration and for all applications under nominal conditions described in section 7.3 (fig. 10) and chapter 5.

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| XY - Intrinsic Linearity Error | $L_{E\_XY}$ | -1 | | 1 | Deg. | |
| XZ - Intrinsic Linearity Error | $L_{E\_XZ}$ | -2.5 | $\pm1.25$ | 2.5 | Deg. | |
| YZ - Intrinsic Linearity Error | $L_{E\_YZ}$ | -2.5 | $\pm1.25$ | 2.5 | Deg. | |
| Noise [32] | | | 0.05 | 0.1 | Deg. | Filter = 0, 40mT |
| | | | 0.1 | 0.2 | | Filter = 0, 20mT |
| | | | 0.05 | 0.1 | | Filter = 2 |
| XY - Total Drift [33] | $\partial\theta_{TT\_XY}$ | -0.45 | | 0.45 | Deg. | Relative to 35°C |
| XZ - Total Drift [33] | $\partial\theta_{TT\_XZ}$ | -0.6 | | 0.6 | Deg. | Relative to 35°C |
| YZ - Totla Drift [33] | $\partial\theta_{TT\_YZ}$ | -0.6 | | 0.6 | Deg. | Relative to 35°C |
| Hysteresis | | | 0.05 | 0.1 | Deg. | 20mT |

*Table 24 - Standard Mode Nominal Magnetic Performances*

### 8.4.2. Limited Performances

Valid before EoL calibration and for all applications under limited performances conditions described in section 7.3 (fig. 10) and chapter 5.

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| XY - Intrinsic Linearity Error | $L_{E\_XY}$ | -1 | | 1 | Deg. | |
| XZ - Intrinsic Linearity Error | $L_{E\_XZ}$ | -2.5 | $\pm1.25$ | 2.5 | Deg. | |
| YZ - Intrinsic Linearity Error | $L_{E\_YZ}$ | -2.5 | $\pm1.25$ | 2.5 | Deg. | |
| Noise [32] | | | 0.2 | 0.4 | Deg. | Filter = 0 |
| | | | 0.14 | 0.28 | | Filter = 1 |
| | | | 0.1 | 0.2 | | Filter = 2 |
| XY - Total Drift [33] | $\partial\theta_{TT\_XY}$ | -0.6 | | 0.6 | Deg. | Relative to 35°C |
| XZ - Total Drift [33] | $\partial\theta_{TT\_XZ}$ | -0.8 | | 0.8 | Deg. | Relative to 35°C |
| YZ - Total Drift [33] | $\partial\theta_{TT\_YZ}$ | -0.8 | | 0.8 | Deg. | Relative to 35°C |
| Hysteresis | | | 0.1 | 0.2 | Deg. | 10mT |

*Table 25 - Standard Mode Limited Magnetic Performances*

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[32] *±3σ*

[33] *Verification done on new and aged devices in an ideal magnetic field (see 8.1.2). An additional application-specific error arises from the non-ideal magnet and mechanical tolerance drift.*

# 9. Memory Specifications

| Parameter | Symbol | Min | Typ | Max | Unit | Note |
|---|---|---|---|---|---|---|
| ROM | ROMsize | | 32 | | kB | 1 bit parity check (single error detection) |
| RAM | RAMsize | | 1024 | | B | 1 bit parity check (single error detection) |
| NVRAM | NVRAMsize | | 256 | | B | 6 bits ECC (single error correction, double error detection) |

*Table 26 - Memory Specifications*

# 10. Digital output protocol

## 10.1. PWM (pulse width modulation)

### 10.1.1. Definition

$$\%\text{Duty Cycle} = T_{ON} / T_{PWM}$$
$$\%\text{DC Jitter} = J_{DC} = J_{ON} / J_{PWM}$$



Jitter on $T_{ON}$ = $J_{ON}$

Jitter on $T_{PWM}$ = $J_{PWM}$

Output (V)

Time (s)
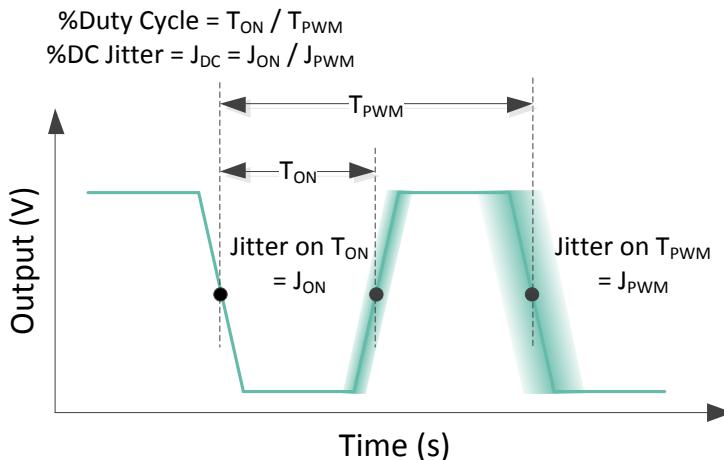
*fig. 12 - PWM Signal definition*

| Parameter | Symbol | Test Conditions |
|---|---|---|
| PWM period | $T_{PWM}$ | Trigger level = 50% $V_{DD}$ |
| Rise time, Fall time | $t_{rise}$, $t_{fall}$ | Between 20% and 80% of $V_{DD}$, see Table 12 for values |
| Jitter | $J_{ON}$ $J_{PWM}$ | ±3σ for 1000 successive acquisitions with clamped output |
| Duty Cycle | DC | $T_{ON} / T_{PWM}$ |

*Table 27 - PWM Signal definition*

### 10.1.2. PWM performances

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| PWM Output Resolution | $R_{pwm}$ | | 0.024 | 0.051 | %DC/LSB | 2kHz. Worst case error for 160°C |
| PWM %DC Jitter | $J_{DC}$ | | | 0.03 | %DC | Push-Pull, 2kHz, $C_L$=10nF, $R_{LPU}$ =4.7kΩ |
| PWM Period Jitter | $J_{pwm}$ | - | - | 300 | ns | Push-Pull, 2kHz, $C_L$=10nF, $R_{LPU}$=4.7kΩ |
| PWM %DC thermal drift | | | 0.02 | 0.05 | %DC | Push-Pull, 2kHz, $C_L$=10nF, $R_{LPU}$=4.7kΩ |

*Table 28 - PWM Signal Specifications*

## 10.2. Single Edge Nibble Transmission (SENT) SAE J2716

The MLX90374 can be configured to provide a digital output signal compliant with SAE J2716 Revised APR2016.

### 10.2.1. Sensor message definition

The MLX90374 repeatedly transmits a sequence of pulses, corresponding with a sequence of nibbles (4 bits), with the following sequence:

- Calibration/Synchronization pulse period 56 clock ticks to determine the time base of the SENT frame
- One 4 bits Status and Serial Communication nibble pulse
- A sequence of one up to six 4 bits data nibble pulses representing the values of the signal(s) to be transmitted. The number of nibbles will be fixed for each application of the encoding scheme (i.e. Singe Secure sensor format A.3, Throttle positions sensor A.1)
- One 4 bits Checksum nibble pulse
- One optional pause pulse

See also SAE J2716 APR2016 for general SENT specification.
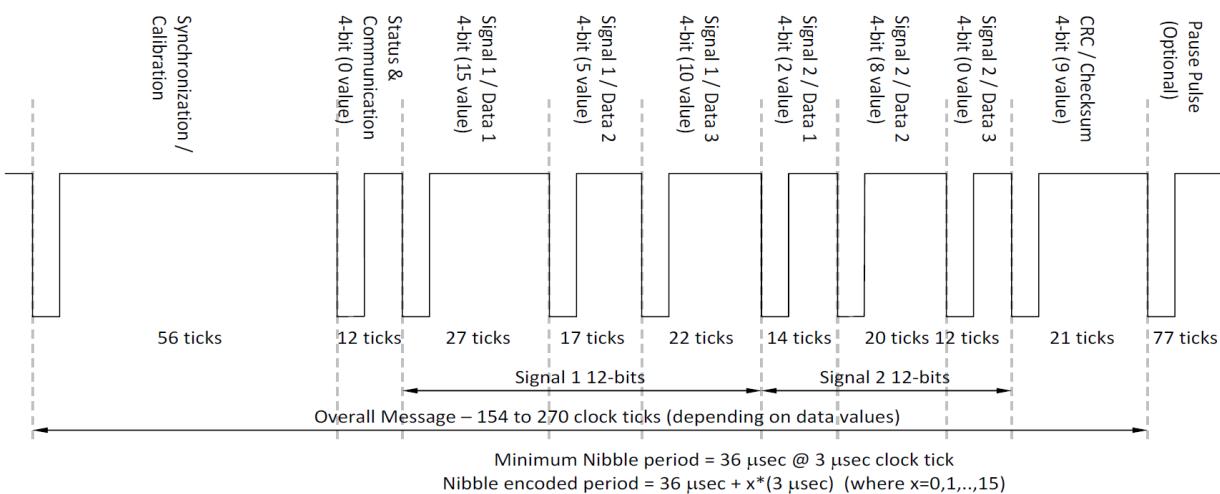


*fig. 13 - SENT message encoding example for two 12bits signals*

## 10.2.2. Sensor message frame contents

The MLX90374 SENT transmits a sequence of data nibbles, according to the following configurations:

| Description | Symbol | Min | Typ | Max | Unit | Description |
|---|---|---|---|---|---|---|
| SENT | SENTrev | | 2010 | 2016 | | SENT revision. Supports enhanced serial channel messages (2016) |
| Clock tick time | tickTime | 1 | 3 | 12 | µs | Main use cases : Fast SENT, 1.5µs tick time Normal SENT, 3µs tick time Slow SENT, 6µs tick time (see section 6.5) |
| Number of data nibbles | Xdn | 3 | 6 | | | |
| Frame duration (no pause pulse) | Npp | 154 | | 270 | ticks | 6 data nibbles |
| Frame duration with pause pulse | Ppc | 282 | 320 | 922 | ticks | Valid for 3µs tick time |
| Sensor type | A.1 A.3 | | | | | Dual Throttle Position sensors Single Secure sensors |

*Table 29 - SENT Protocol Frame Definition*

## 10.2.3. Single secure sensor A.3

The MLX90374 SENT transmits a sequence of data nibbles; according single secure sensor format defined in SAE J2716 appendix A.3.The frame contains 12-bit angular value, a 8 bits rolling counter and an inverted copy of the most significant nibble of angular value. This format is activated when SENT_SS bit is set to 1 (see Table 42, #137)
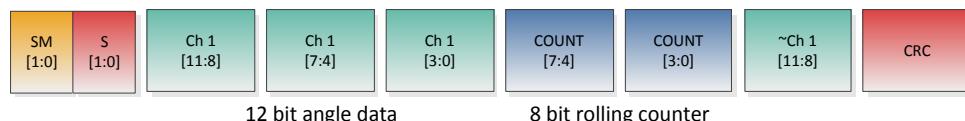


*fig. 14 - A.3 Single Secure Sensor Frame Format*

| Shorthand Description | Tick time | Data nibbles | Pause Pulse | Serial message | Data format |
|---|---|---|---|---|---|
| SENT2010-03.0us-6dn-ppc(366.0)-esp-A.3 | 3 us | 6 | Y | Enhanced | A.3 |
| SENT2010-03.0us-6dn-ppc(366.0)-nsp-A.3 | 3 us | 6 | Y | None | A.3 |
| SENT2010-03.0us-6dn-npp-nsp-A.3 | 3 us | 6 | N | None | A.3 |
| SENT2010-##-#us-#dn-###()-###-A.3 | 1..12 | 6 | Y/N | En/None | A.3 |

*Table 30 - A.3 Single Secure Sensor Shorthand examples*

## 10.2.4. Dual Throttle position sensor A.1

The MLX90374 SENT transmits a sequence of data nibbles; according dual throttle positions sensor defined in SAE J2716 appendix A.1.The frame contains two 12-bit angular values.
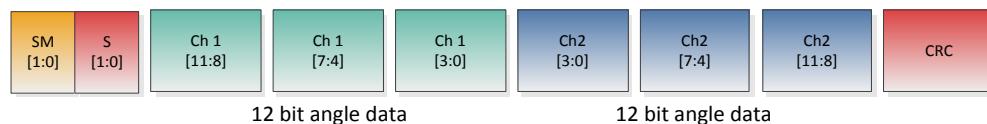


*fig. 15 - A.1 Dual Throttle Position Sensor Frame Format*

| Shorthand Description | Tick time | Data nibbles | Pause Pulse | Serial message | Data format |
|---|---|---|---|---|---|
| SENT2010-03.0us-6dn-ppc(366.0)-esp-A.1 | 3 us | 6 | Y | Enhanced | A.1 |
| SENT2010-03.0us-6dn-ppc(366.0)-nsp-A.1 | 3 us | 6 | Y | None | A.1 |
| SENT2010-03.0us-6dn-npp-nsp-A.1 | 3 us | 6 | N | None | A.1 |
| SENT2010-##-#us-#dn-###()-###-A.1 | 1..12 | 6 | Y/N | En/None | A.1 |

*Table 31 - A.1 Dual Throttle Position Sensor Shorthand Examples*

Second fast channel configuration:

| SENT_FAST_CHANNEL_2 | CH2 configuration (ABB revision) | CH2 configuration (ABC revision) |
|---|---|---|
| 0 | Temperature sensor (SP ID 0x23) | Temperature sensor (SP ID 0x23) |
| 1 | 0xFF9(d4089) - CH1 | Second Output (see 12.3) |
| 2 | RAM data (RAMPROBE_PTR) | RAM data (RAMPROBE_PTR) |
| 3 | 0xFFF(d4095) - CH1 | 0xFFF(d4095) - CH1 |

*Table 32 - A.1 Dual Throttle Position Sensor Fast Channel 2 configuration*

## 10.2.5. Start-up behaviour

The circuit will start to send initialisation frames once digital start-up is done but angle measurement initialisation sequence is not yet complete. These initialisation frames content can be chosen by user with the following option:

| SENT_INIT_GM | Initialisation frame value | Comments |
|---|---|---|
| 0 | 0x000 | SAE compliant |
| 1 | 0xFFF | OEM requirement |

*Table 33 - Initialisation Frame Content Definition*

## 10.2.6. SENT Output Timing configuration

| SENT_TICK_TIME | Tick time configuration | Description |
|:---:|:---:|:---:|
| 0 | 3 µs | Standard SENT |
| 1 | 0.5 µs | Not recommended |
| 2 | 1 µs | Not recommended |
| 3 | 1.5 µs | Fast SENT |
| 4 | 2.0 µs | Not recommended |
| 5 | 2.5 µs | Not recommended |
| 6 | 6 µs | Slow SENT |
| 7 | 12 µs | Not recommended |

*Table 34 - SENT Tick Time Configuration*

| SENT_SEL_SR_FALL | Fall time ($T_{fall}$) |
|:---:|:---:|
| 0 | No slew rate control |
| 1 | 0.7 µs |
| 2 | 1.2 µs |
| 3 | 1.9 µs |
| 4 | 4.8 µs |
| 5 | 9.6 µs |
| 6 | 19 µs |
| 7 | 24 µs |

| SENT_SEL_SR_RISE | Rise Time ($T_{rise}$) |
|:---:|:---:|
| 0 | No slew rate control |
| 1 | 0.9 µs |
| 2 | 1.6 µs |
| 3 | 3.0 µs |
| 4 | 6.2 µs |
| 5 | 12 µs |
| 6 | 24 µs |
| 7 | 30 µs |

*Table 35 - SENT Rise and Fall Times Configuration*
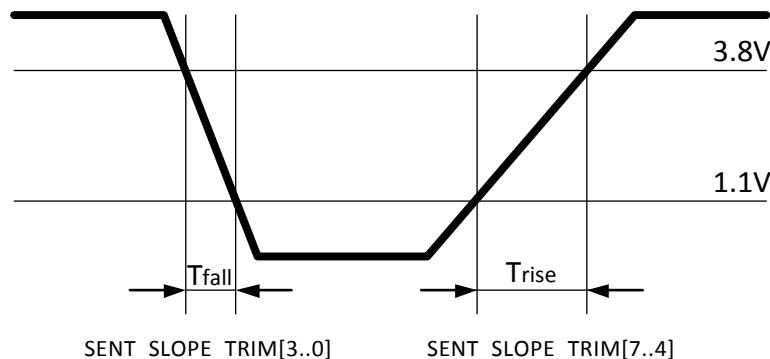


*fig. 16 - SENT Rise and Fall Times configuration*

| NIBBLE_PULSE_CONFIG | High/low time configuration |
|:---:|:---:|
| 2 | Fixed low time (5 ticks) |
| 3 | Fixed high time (6 ticks)[34] |

*Table 36 - SENT Nibble configuration (high/low times)*

## 10.2.7. Serial message channel (slow channel)

Serial data is transmitted serial in bit number 3 and 2 of the status and communication nibble. A serial message frame stretches over 18 consecutive SENT data messages from the transmitter. All 18 frames must be successfully received (no errors, calibration pulse variation, data nibble CRC error, etc.) for the serial value to be received.

Enhanced format with 12-bits data and 8-bits message ID is used (SAE J2716 APR2016 5.2.4.2, fig. 5.2.4.2-2). According to the standard, SM[0] contains a 6bits CRC followed by a 12-bits data. Message content is defined by a 8-bit message ID transmitted in the SM[1] channel. Correspondence between ID and message content is defined in the tables below (Table 37, Table 38 and Table 39).
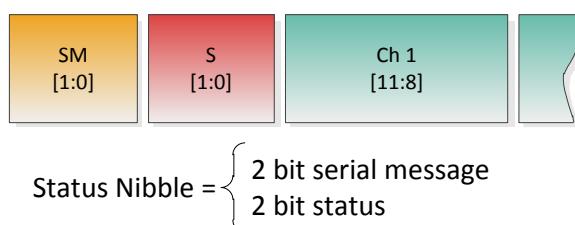


*fig. 17 - SENT Status Nibble and Serial Message*

By default, the short sequence consisting of a cycle of 24 data is transmitted (Table 37). An extended sequence can be used through configuration of SENT_SLOW_EXTENDED (Table 38). Additionally, the norm of the B field detected by the sensor can be returned at the end of the sequence by setting SENT_SLOW_BFIELD (Table 39).

| # | 8bit ID | Item | Source data |
|:---:|:---:|:---:|:---:|
| 1 | 0x01 | Diagnostic error code | Current status code from RAM |
| 2 | 0x06 | SENT standard revision | SENT_REV from NVRAM |
| 3 | 0x01 | Diagnostic error code | Current status code from RAM |
| 4 | 0x05 | Manufacturer code | SENT_MAN_CODE from NVRAM |
| 5 | 0x01 | Diagnostic error code | Current status code from RAM |
| 6 | 0x03 | Channel 1 / 2 Sensor type | SENT_SENSOR_TYPE from NVRAM |
| 7 | 0x01 | Diagnostic error code | Current status code from RAM |
| 8 | 0x07 | Fast channel 1: X1 | SENT_CHANNEL_X1 from NVRAM |
| 9 | 0x01 | Diagnostic error code | Current status code from RAM |

---

[34] *When using fixed high time in normal SENT mode, Melexis recommends lowering SENT_SEL_SR_RISE to 3 or setting ABE_OUT_MODE to 2 to two to avoid potential timing degradation on short nibbles.*

| # | 8bit ID | Item | Source data |
|---|---------|------|-------------|
| 10 | 0x08 | Fast channel 1: X2 | SENT_CHANNEL_X2 from NVRAM |
| 11 | 0x01 | Diagnostic error code | Current status code from RAM |
| 12 | 0x09 | Fast channel 1: Y1 | SENT_CHANNEL_Y1 from NVRAM |
| 13 | 0x01 | Diagnostic error code | Current status code from RAM |
| 14 | 0x0A | Fast channel 1: Y2 | SENT_CHANNEL_Y2 from NVRAM |
| 15 | 0x01 | Diagnostic error code | Current status code from RAM |
| 16 | 0x23 | (Internal) temperature | Current temperature from RAM |
| 17 | 0x01 | Diagnostic error code | Current status code from RAM |
| 18 | 0x29 | Sensor ID #1 | SENT_SENSOR_ID1 from NVRAM |
| 19 | 0x01 | Diagnostic error code | Current status code from RAM |
| 20 | 0x2A | Sensor ID #2 | SENT_SENSOR_ID2 from NVRAM |
| 21 | 0x01 | Diagnostic error code | Current status code from RAM |
| 22 | 0x2B | Sensor ID #3 | SENT_SENSOR_ID3 from NVRAM |
| 23 | 0x01 | Diagnostic error code | Current status code from RAM |
| 24 | 0x2C | Sensor ID #4 | SENT_SENSOR_ID4 from NVRAM |

*Table 37 - SENT Slow Channel Standard Data Sequence*

| # | 8bit ID | Item | Source data |
|---|---------|------|-------------|
| 25 | 0x01 | Diagnostic error code | Current status code from RAM |
| 26 | 0x90 | OEM Code #1 | SENT_OEM_CODE1 from NVRAM |
| 27 | 0x01 | Diagnostic error code | Current status code from RAM |
| 28 | 0x91 | OEM Code #2 | SENT_OEM_CODE2 from NVRAM |
| 29 | 0x01 | Diagnostic error code | Current status code from RAM |
| 30 | 0x92 | OEM Code #3 | SENT_OEM_CODE3 from NVRAM |
| 31 | 0x01 | Diagnostic error code | Current status code from RAM |
| 32 | 0x93 | OEM Code #4 | SENT_OEM_CODE4 from NVRAM |
| 33 | 0x01 | Diagnostic error code | Current status code from RAM |
| 34 | 0x94 | OEM Code #5 | SENT_OEM_CODE5 from NVRAM |
| 35 | 0x01 | Diagnostic error code | Current status code from RAM |
| 36 | 0x95 | OEM Code #5 | SENT_OEM_CODE6 from NVRAM |
| 37 | 0x01 | Diagnostic error code | Current status code from RAM |
| 38 | 0x96 | OEM Code #5 | SENT_OEM_CODE7 from NVRAM |
| 39 | 0x01 | Diagnostic error code | Current status code from RAM |
| 40 | 0x97 | OEM Code #8 | SENT_OEM_CODE8 from NVRAM |

*Table 38 - SENT Slow Channel Extended Data Sequence*

| # | 8bit ID | Item | source data |
|---|---------|------|-------------|
| 25 | 0x80 | Field Strength | Bfield_norm from RAM (standard sequence) |
| 41 | 0x80 | Field Strength | Bfield_norm from RAM (extended sequence) |

*Table 39 - SENT Slow Channel Magnetic Field Norm ID and position*

For Field Strength encoding, see chapter 7, Magnetic Field Specifications, under the section corresponding to the selected application.

## 10.2.8. Serial Message Error Code

The list of error and status messages transmitted in the 12-bit Serial Message data field when Serial Message 8-bit ID is 0x01, is given in the Table 40. The error is one-hot encoded and therefore each bit is linked to one or several monitor. Only the first error detected is reported and serial message error code will not be updated until all the errors have disappeared. This mechanism ensures only one error at a time takes control of the error debouncing counter (see 12.4.2).

The MSB acts as an error Flag when SENT_DIAG_STRICT is set. This bit will be high only when an error is present. For compatibility with previous Triaxis®, this bit can be kept high even if no error is present (SENT_DIAG_STRICT = 0).

| Bit Nb | 12 Bit Data (hex) | Diagnostic | Comments |
|--------|-------------------|------------|----------|
| - | 0x000 / 0x800 | No error | Programmable (SENT_DIAG_STRICT, see Table 42, no 151) |
| 0 | 0x801 | GainOOS | Gain out of spec (see GAIN_MIN, GAIN_MAX) |
| 1 | 0x802 | FieldTooLow | Fieldstrength below defined low threshold (see Table 42, no 103) |
| 2 | 0x804 | FieldTooHigh | Fieldstrength above defined high threshold (see Table 42, no 104) |
| 3 | 0x808 | ADCclip | ADC is saturated, either low or high |
| 4 | 0x810 | ADC_test | ADC wrong conversion |
| 5 | 0x820 | Analog Supply Monitors | Detects VDDA (VDEC) over and under voltage or VDD under voltage |
| 6 | 0x840 | Digital Supply Monitors | Detects VDDD (1.8V internal digital supply) overvoltage |
| 7 | 0x880 | RoughOffset | Hall Element offset monitor |
| 8 | 0x900 | Over/Under Temp | Temperature sensor monitor (see 12.4.3) |
| 9 | 0xA00 | HE_Bias / Analog Front End | Hall Element biasing issue / Analog front end self-test ([35]) |

[35] Only available on MLX90374 ABC version (not on ABB)

| Bit Nb | 12 Bit Data (hex) | Diagnostic | Comments |
|--------|-------------------|------------|----------|
| 10 | 0xC00 | Suply Bias Current | Current biasing system monitor |
| 11 | 0x800 | Extra Error Flag | set to one if any error present (only when SENT_DIAG_STRICT = 1). Otherwise, always high. |

*Table 40 - SENT Serial Message Error Code*

## 10.2.9. SENT configuration shorthand definition

| Shorthand description | Format | Req | 90374 programmable setting |
|-----------------------|--------|-----|----------------------------|
| SENT SAE J2716 Rev | SENT xxxx | 2007<br>2008<br>2010<br>2016 | **CRC_2007**<br>0　　> 2007<br>1　　2007 |
| Clock Tick length [µs] | XX.X µs | 0.5<xx<12 | **SENT_TICK_TIME**<br>0　SENT　3.0µs<br>1　SENT　0.5µs<br>2　SENT　1µs<br>3　SENT　1.5µs<br>4　SENT　2.0µs<br>5　SENT　2.5µs<br>6　SENT　6.0µs<br>7　SENT　12.0µs |
| Number of data Nibbles | X dn | 3 ≤ x ≤ 6 | **EN_FAST_CH2**<br>0　　3 Data nibbles<br>1　　6 Data nibbles |
| Pause Pulse Option | npp<br>ppc<br>(xxx.0)<br><br>xxx | No pause Pulse<br>Pause Pulse with const. frame length<br><br>Frame Length (in clock ticks) | **PROTOCOL**<br>0　　= npp<br>2　　= ppc<br><br>**T_FRAME**<br>xxx　　> 282...922 |
| Use of Serial protocol | nsp<br>ssp<br>esp | No serial protocol<br>Short serial protocol<br>Enhanced serial protocol | **SERIAL_CONFIG**<br>1　　nsp<br>2　　ssp (not compliant)<br>3　　esp |
| Sensor type | A.1<br>A.3 | Dual Throttle Position sensor<br>Single secure sensor | **SENT_SS**<br>0　　A.1<br>1　　A.3 |

*Table 41 - SENT Shorthand Description*

# 11. End-User Programmable Items

| Parameter | PSF value | Description | Default Values | |
|---|---|---|---|---|
| | | | **Standard** | **#bits** |
| **GENERAL CONFIGURATION** | | | | |
| USER_ID[0..5] | 1..6 | User Id. Reference. Reserved for customer traceability | see 11.1 | 6 x 8 |
| MEMLOCK | 179 | Disable NVRAM write (memory LOCK) | 0 | 2 |
| WARM_ACT_HIGHV | 238 | Enable battery application ($V_{DD}$ > 5 V) | 0 | 1 |
| WARM_TRIGGER_LONG | 174 | Add delay to enter PTC mode (MT7V) | 0 | 1 |
| **SENSOR FRONT-END** | | | | |
| MAGNET_SREL_T[1..7] | 7..13 | Magnet Relative sensitivity at temperature Tx [36] | 255 | 8 |
| GAINMIN | 14 | Low threshold for virtual gain | 01 | 8 |
| GAINMAX | 15 | High threshold for virtual gain | 63 | 8 |
| GAINSATURATION | 26 | Gain Saturates on GAINMIX and GAINMAX | 0 | 1 |
| SENSING_MODE | 18 | **Mapping fields for output angle**<br>Rotary stray field Immune -- order code 100<br>Linear position stray field Immune -- order code 200<br>Linear position / Angular Rotary -- order code 300 | 0<br>4<br>1-3 | 3 |
| DSP_NB_CONV[37] | 19 | Number of phase spinning within ADC sequence<br>0=4 phase spinning | 0[37] | 2 |
| EN_USER_FE_TRIMMING | 125 | Enable Additional Virtual Offset | 0 | 1 |
| B_OFS_1 | 161 | Virtual Offset on component B1 (Warning! if used overwrites USERID[2] and USERID[3]) | 0 | 16 |
| B_OFS_2 | 163 | Virtual Offset on component B2 (Warning! if used overwrites USERID[4] and USERID[5]) | 0 | 16 |
| **DSP – FILTERING** | | | | |
| FILTER | 21 | Filter mode selection | 1 | 2 |
| HYST | 16 | Hysteresis threshold for EMA (IIR) filter | 0 | 8 |
| DENOISING_FILTER_ALPHA_SEL | 95 | Select the alpha parameter of the EMA (IIR) filter | 0 | 2 |
| **DSP – ANGLE MAPPING FUNCTIONS** | | | | |
| CW | 20 | Set rotation to clockwise | 0 | 1 |
| DP | 27 | Discontinuity point | 0 | 16 |
| WORK_RANGE_GAIN | 217 | Re-scaling before the piece-wise linearization step | 16 | 8 |
| WORKING_RANGE | 23 | 17, 32pts - Output angle range<br>(= limited selection of WORK_RANGE_GAIN) | 0 | 3 |
| 4POINTS | 22 | Select LNR method 4 pts | 0 | 1 |

[36] *This parameter is mainly intended to be used in Linear Hall mode (no IMC) or with Virtual Offset. It is strongly recommended to keep default values.*

[37] *Changing default value could impact the safety metrics. Default value shall be used.*

| Parameter | PSF value | Description | Default Values | |
|---|---|---|---|---|
| | | | Standard | #bits |
| DSP_LNR_RESX2 | 94 | Enable a double resolution LNR method<br>0: 4-points or 16-segments<br>1: 8-points or 32-segments | 0 | 1 |
| GAIN_ANCHOR_MID | 225 | re-scaling before the piece-wise linearization step | 1 | 1 |
| LNRS0, LNRAS.. LNRDS | | 4pts –Slope for reference points A, B, C, D | N/A | 16 |
| LNRAX, LNRBX.. LNRDX | | 4pts - X Coordinate for reference points A, B, C, D | N/A | 16 |
| LNRAY, LNRBY.. LNRDY | | 4pts - Y Coordinate for reference points A, B, C, D | N/A | 16 |
| LNRY0..Y16 | | 17 pts - Y coordinate point 0..16 | 1-4088 | 16 |
| LNRX0..X7 | | 8 pts - X coordinate point 0..7 | N/A | 16 |
| LNR_DELTA_Y01..Y32 | 192.. 223 | Delta Y for 32-segment linearization | 0..255 | 8 |
| LNR_DELTA_Y_EXPAND_LOG2 | 97 | Adjust the span of LNR_DELTA_Yn parameters | 0 | 2 |
| USEROPTION_SCALING | 24 | Enables the output scaling function (x2)<br>0 = [0..100%]<br>1 = [-50..150%] | 1 | 1 |
| CLAMPLOW | 87 | Low clamping value of angle data | 3277 | 16 |
| CLAMPHIGH | 88 | High clamping value of angle data | 62259 | 16 |
| CLAMP2_EN [38] | 244 | Enable specific OUT2 clamping | 1 | 1 |
| CLAMPLOWOUT2 [38] | 241 | Specific low clamping value for OUT2 data | 3277 | 16 |
| CLAMPHIGHOUT2 [38] | 242 | Specific high clamping value for OUT2 data | 62259 | 16 |
| OUT2SLOPERATIO [38] | 245 | Relative angle working range between both outputs | 61440 | 16 |
| OUT2OFFSET [38] | 247 | Relative angle reference between both outputs | 8191 | 1 |
| OUTSLOPE_SEL [38] | 246 | Select temperature-dependent offset (see 12.2.8) | 0 | 2 |
| OUTSLOPE_COLD [38] | 253 | Slope coefficient at cold of the programmable temperature-dependent offset (signed value) | 0 | 8 |
| OUTSLOPE_HOT [38] | 254 | Slope coefficient at Hot of the programmable temperature-dependent offset (signed value) | 0 | 8 |
| **DIAGNOSTICS** | | | | |
| DIAG_TEMP_THR_LOW [37] | 101 | Temperature threshold for under-temperature diagnostic | 8 [37] | 8 |
| DIAG_TEMP_THR_HIGH [37] | 102 | Temperature threshold for over-temperature diagnostic | 136 [37] | 8 |
| DIAG_FIELDTOOLOWTHRES | 103 | Field limit under which a fault is reported. **On revision ABB, need to be programmed by user to be active**. Each LSB of this threshold corresponds to 4 LSB of the field strength. | [39] | 8 |

[38] *Only available on ABC revision*

[39] *Default value depends on application and IC revision. See chapter 7 tables for more information.*

| Parameter | PSF value | Description | Default Values | |
|---|---|---|---|---|
| | | | **Standard** | **#bits** |
| DIAG_FIELDTOOHIGHTHRES | 104 | Field limit over which a fault is reported. Each LSB of this threshold corresponds to 4 LSB of the field strength. | 255 | 8 |
| PWM WEAKMAGTHRESH | 105 | Weak Magnet threshold Byte (PWM only) | 0 | 8 |
| DIAGDEBOUNCE_STEPDOWN | 107 | Diagnostic debouncing stepdown time | 1 | 4 |
| DIAGDEBOUNCE_STEPUP | 108 | Diagnostic debouncing step-up time | 2 | 4 |
| DIAGDEBOUNCE_THRESH | 110 | Diagnostic debouncing threshold | 2 | 6 |
| DIAG_EN[37] | 111 | Diagnostics global enable. **Do not modify!** (see 13.2 Safety Mechanisms) | 1[37] | 1 |
| COLD_SAFE_STARTUP_EN | 112 | Normal (0) or full safe (1) start-up after power-on reset (see 6.3.1) | 0 | 1 |
| OUT_DIAG_HIZ_TIME | 177 | Duration of output High-Z after transient digital fault, **do not modify!** | - | 3 |

**OUTPUT CONFIGURATION**

| Parameter | PSF value | Description | Default Values | |
|---|---|---|---|---|
| | | | **Standard** | **#bits** |
| PROTOCOL | 114 | Select digital output communication mode<br>0 = SENT without pause pulse<br>1 = PWM (default)<br>2 = SENT with pause | 1 | 2 |
| PWM_OUT_MODE [38] | 251 | Diagnostic reporting mode for dual PWM signals<br><br>| | OUT1 | OUT2 |<br>|---|---|---|<br>| 0 | Fault Duty Cycle | 1-Fault Duty Cycle |<br>| 1 | Angle Value | 1-Fault Duty Cycle |<br>| 2 | Fault Duty Cycle | OUT2 Angle Value |<br><br>When OUT2 is in Kickdown mode, OUT1 always reports the fault Duty Cycle | 0 | 2 |
| PWM2_EN | 115 | Enables the second PWM Output | 1 | 1 |
| OUT_ALWAYS_HIGHZ | 119 | Forces primary output (SENT/PWM) to high-Z mode | 0 | 1 |
| TWO_ANGLES_FRAME | 138 | Enable 2 angle measurements per period in synchronous mode (SENT w/ pause pulse) | 1 | 1 |
| NIBBLE_PULSE_CONFIG | 233 | SENT nibble high/low-time configuration<br>2 = Fixed 5 ticks low<br>3 = Fixed 6 ticks high | 2 | 2 |
| T_FRAME | 147 | SENT Frame Tick Count / PWM period (4µs/LSB). **! Has impact on the analog diagnostics DCT** (see Table 9 - General Timing Specifications) | 250 | 12 |
| T_SYNC_DELAY[37] | 150 | SENT - ADC synchronization delay | 21[37] | 12 |
| ABE_OUT_MODE | 175 | Output physical configuration<br>00: SENT mode = digital push-pull<br>01: SENT mode = open-drain<br>10: PWM mode = digital fast push-pull<br>11: PWM open-drain | 0 | 2 |
| SENT_SEL_SR_FALL | 255 | SENT/PWM slope fall time configuration (see Table 35) | 4 | 3 |

| Parameter | PSF value | Description | Default Values | |
|---|---|---|---|---|
| | | | **Standard** | **#bits** |
| SENT_SEL_SR_RISE | 256 | SENT/PWM slope rise time configuration (see Table 35) | 4 | 3 |
| ABE_OUT_CFG | 176 | Output pin configuration, **do not modify!** | 0 | 2 |
| ROUT_LOW | 178 | Option for output pull-up resistor<br>0: > 200 Ohms<br>1: < 200 Ohms | 1 | 1 |
| **SWITCH FUNCTIONS** | | | | |
| KICKDOWN_EN | 190 | Enable the switch function on OUT2 (ABB version) | 0 | 1 |
| KICKDOWN_EN [38] | 190 | Switch configuration for ABC revision<br>0 = no switch function<br>1 = Switch1 on Test output<br>2 = Switch1 on OUT2<br>3 = Switch1 on OUT2, Switch2 on Test output | 0 | 2 |
| KICKDOWN_POL | 189 | 0: Normal polarity (kickdown=1 if input>threshold)<br>1: Inverted polarity (kickdown=1 if input<threshold) | 0 | 1 |
| KICKDOWN_THRES_UP | 187 | Switch1 threshold | 255 | 12 |
| KICKDOWN_THRES_HYST | 188 | Switch1 hysteresis | 3 | 2 |
| KICKDOWN_THRES_UP2 [38] | 249 | Switch2 threshold | 255 | 12 |
| KICKDOWN_THRES_HYST2 [38] | 250 | Switch2 hysteresis | 3 | 2 |
| **PWM PROTOCOL OPTIONS** | | | | |
| PWM_POL | 116 | Invert the PWM polarity | 0 | 1 |
| PWM_SRC | 117 | For debugging purpose only: **do not change!** | 0 | 1 |
| PWM_REPORT_MODE_ANA | 118 | Error message within PWM frame<br>0x0: PWM - config 2 (PWM signal in fault band)<br>0x1: PWM - config 1 (HiZ)<br>0x2: Output = config 3.a (0 constant)<br>0x3: Output = config 3.b (1 constant) | N/A | 2 |
| PWM_DC_FAULT | 120 | PWM Duty Cycle in case of Fault | 4 | 8 |
| PWM_DC_FIELDTOOLOW | 121 | PWM Duty Cycle in case of Field Strength Too Low | 10 | 8 |
| PWM_DC_WEAKMAG | 122 | PWM Duty Cycle in case of Weak Magnet | 6 | 8 |
| **SENT PROTOCOL OPTIONS** | | | | |
| STATUS_IN_CRC | 124 | Add first nibble in SENT CRC calculation | 0 | 1 |
| EN_FAST_CH2 | 126 | Enable SENT fast channel two | 1 | 1 |
| SENT_CH1_SRC_SEL[37] | 127 | Selection of the SENT channel 1 source:<br>0: Angle<br>1: RAM data at addr SENT_CH2_PTR | 0[37] | 1 |
| RAMPROBE_PTR | 129 | Data to be transmitted in SENT channel 2 | 0 | 16 |
| SENT_MAN_CODE | 131 | Serial data message Manufacturer code | 6 | 12 |
| SENT_REV | 132 | Serial data message SENT rev (same as SENT_SLOW_MESSAGE_0) | 4 | 12 |
| SENT_SENSOR_TYPE | 134 | Serial data message SENSOR_TYPE | 0x050 | 12 |

| Parameter | PSF value | Description | Default Values | |
|---|---|---|---|---|
| | | | Standard | #bits |
| SENT_TICK_TIME[37] | 136 | SENT tick time | 0[37] | 3 |
| SENT_SS | 137 | Enable Single Secure sensor format A.3 | 1 | 1 |
| SENT_SLOW_EXTENDED | 139 | Enable enhanced serial message ID OEM code 25-40 | 0 | 1 |
| SENT_FAST_CHANNEL_2 | 141 | Configuration channel 2 if NV_SENT_SS=0 | 2 | 2 |
| SENT_LEGACY_CRC | 142 | Enable SENT2007 CRC calculation | 0 | 1 |
| SENT_SLOW_BFIELD | 143 | Enable enhanced serial message ID 80 | 0 | 1 |
| SENT_REPORT_MODE_ANA | 144 | Error message within SENT frame in diagnostic mode: <br> 0x0: SENT - Status bit S0 is set <br> 0x1: SENT - Status bit S0 is set and data = FF9 + DIAG_FAULT_CODE (FFF by default) <br> 0x2: SENT - Status bit S0 is set and the redundant nibble is inverted | 0 | 2 |
| SENT_DIAG_STRICT | 151 | Enhanced serial error reporting option: Disable Bit 11 when no error is present. | 1 | 1 |
| SENT_CHANNEL_X1 | 152 | Serial data message X1 | 0 | 12 |
| SENT_CHANNEL_X2 | 153 | Serial data message X2 | 0 | 12 |
| SENT_CHANNEL_Y1 | 155 | Serial data message Y1 | 0 | 12 |
| SENT_CHANNEL_Y2 | 157 | Serial data message Y2 | 0 | 12 |
| SENT_SENSOR_ID1.4 | 159..164 | Serial data message sensor ID1.. ID4 | 0 | 12 |
| SENT_OEM_CODE1..8 | 165..172 | Serial data message OEM code 1..8 | 0 | 12 |
| SERIAL_CONFIG | 234 | SENT serial configuration <br> 1 = No serial protocol <br> 3 = Enhanced serial protocol <br> **Do not use 0, 1 or 2 to retain safety goal.** | 3 | 2 |
| SENT_INIT_GM | 235 | SENT initialization, <br> 0 = transmitting 0 as initialization data <br> 1 = transmitting 4095 as initialization data | 0 | 1 |
| **INPUT PIN CONFIGURATION** | | | | |
| ABE_INPUT_MODE | 183 | Gateway configuration (Input pin): <br> 0: gateway disabled <br> 2 : analog Gateway, inverted <br> 3: analog gateway <br> 4: digital PWM input mode <br> 5: binary mode | 0 | 3 |
| EXT_POL | 181 | 0x0: In PWM, the input value is proportional to the high-state <br> 0x1: In PWM, the input value is proportional to the low-state | 0 | 1 |
| GTW_SUP_SEL | 184 | Digital gateway supply selection: <br> 0x0: 3.3V VS supply <br> 0x1: 5.0V VS supply | 0 | 1 |

| Parameter | PSF value | Description | Default Values Standard | #bits |
|---|---|---|---|---|
| DIAG_GTW_MIN | 229 | PWM diagnostic: minimum value for comparison. Complex timer 16-bit value is compared to NV_DIAG_GTW_MIN << 12 0xF corresponds to a PWM period of 41322us. | 0 | 4 |
| DIAG_GTW_MAX | 230 | PWM diagnostic: maximum value for comparison. Complex timer 16-bit value is compared to NV_DIAG_GTW_MAX << 12 0xF corresponds to a PWM period of 41322us. | 15 | 4 |
| GTW_BIAS_TR | 239 | bxxx100: Minimum value of the trimmed pull-up resistance (on pin INPUT) bxxx000: Nominal value of the trimmed pull-up resistance bxxx111: Maximum value of the trimmed pull-up resistance b001xxx: Connect a 1kOhm pull-up resistor between VDDA and INPUT b010xxx: Connect a 4kOhm pull-up resistor between VDDA and INPUT b100xxx: Connect a 10kOhm pull-up resistor between VDDA and INPUT | 0 | 6 |

*Table 42 - MLX90374 End-User Programmable Items Table*

Performances described in this document are only achieved by adequate programming of the device. To ensure desired functionality, Melexis recommends following its programming guidelines and contacting its technical or application services. Melexis does not guarantee the safety of the element if the configuration of the device is done outside of the above defined values and recommendations.

## 11.1. End User Identification Items

| Parameter | PSF value | Description | Default Values Standard | #bits |
|---|---|---|---|---|
| USER_ID[0..5] | 1..6 | User Id. References | - | 16 |
| USER_ID0 | 1 | Product Number for 90374ABB<br>Product Number for 90374ABC | 16<br>17 | 8 |
| USER_ID1 | 2 | NVRAM factory default content revision<br>90374 ABB<br>90374 ABC | 8<br>9 | 8 |
| CHIP_VERSION | 667 | 0 : Rotary Stray Field Robust (-1xx ordering code)<br>1 : Angular / Linear position legacy (-3xx ordering code)<br>2 : Linear Stray Field Robust (-2xx ordering code) | - | 7 |
| MLX_ID0 | 669 | X-Y position on the wafer (8 bit each) | - | 16 |
| MLX_ID1 | 672 | Wafer ID (5 bits)<br>Lot ID [10..0] | - | 16 |
| MLX_ID2 | 675 | Lot ID [16..11]<br>Fab ID (4 bits)<br>Test Databse ID (6 bits) | - | 16 |

*Table 43 - Melexis and Customer ID fields description*

User identification numbers (48 bits, 6 words) are freely useable by customers for traceability purpose. Other IDs are read only.

# 12. Description of End-User Programmable Items

## 12.1. Sensor Front-End

The MLX90374 Triaxis® processor front end can be configured with the following parameters

| Parameter | Value |
|---|---|
| SENSING MODE | [0..4] |
| GAINMIN | [0..63] |
| GAINMAX | [0..63] |
| GAINSATURATION | [0, 1] |
| B_OFS_1 | [0..65535] |
| B_OFS_2 | [0..65535] |

*Table 44 - Sensing Mode and Front-End Configuration*

### 12.1.1. SENSING MODE

The SENSING_MODE parameter defines which sensing mode and fields are used to calculate the angle. The different possibilities are described in the tables below. This 2-bit value selects the first (B1) and second (B2) field components according to the Table 45 content.

| SENSING_MODE | B1 | B2 | Angular Mode | Compatible with |
|---|---|---|---|---|
| 0 | X | Y | Angular Rotary stray-field Immune | ordering code -100 |
| 1 | X | Y | X-Y Angular Rotary | ordering code -300 |
| 2 | Y | Z | Y-Z Angular Rotary | ordering code -300 |
| 3 | X | Z | X-Z  Angular Rotary | ordering code -300 |
| 4 | ΔX | ΔZ | Linear position, stray-field Immune | ordering code -200 |

*Table 45 - Sensing Mode Description*

### 12.1.2. GAINMIN and GAINMAX Parameters

GAINMIN and GAINMAX define the thresholds on the gain code outside which the fault "GAIN out of Spec." is reported. If GAINSATURATION is set, then the virtual gain code is saturated at GAINMIN and GAINMAX, and no Diagnostic fault is set since the saturations applies before the diagnostic is checked.

## 12.2. Sensor DSP Configuration

The MLX90374 Triaxis® Processor embeds a DSP that can be used to process the angle information through the signal chain displayed in the fig. 18. The angle input information $\theta_{IN}$ can be shaped through two angular channels $OUT_1$ and $OUT_2$ as well as two switches signal $KD_1$ and $KD_2$. These signals can then be routed to the MLX90374 physical outputs using available communication protocols (see section 12.3, Selection of Output modes).
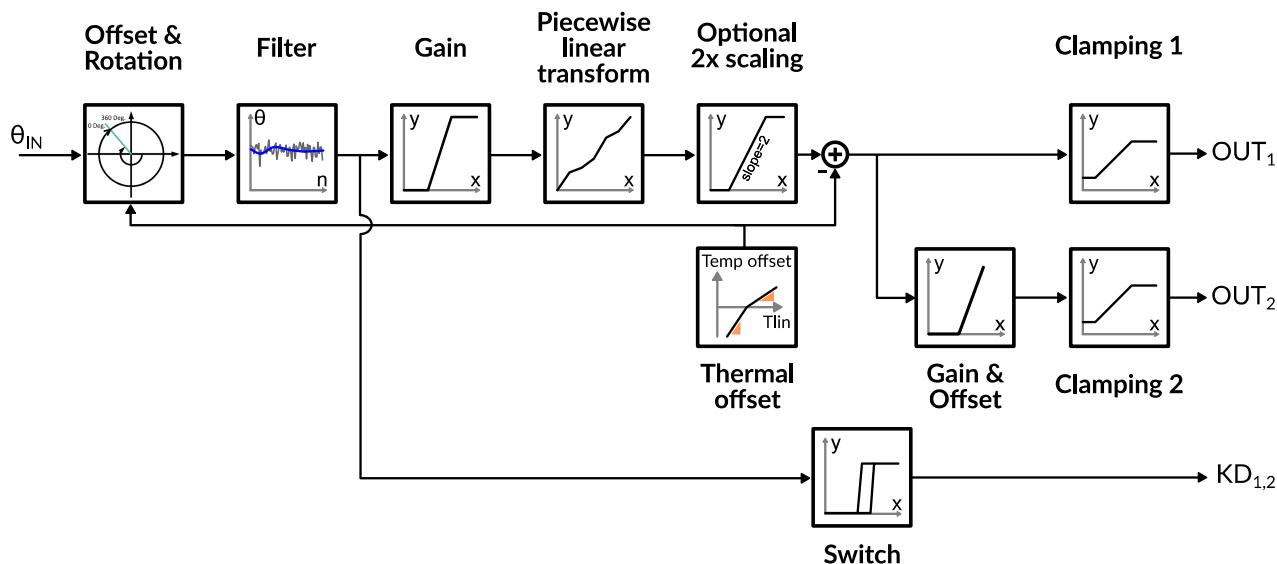


*fig. 18 – MLX90374 Digital Signal Processing Flow*

Following table summarizes the parameters used for the DSP configuration

| Parameter | LNR type | Value | Unit |
|---|---|---|---|
| CW | All | 0 : counter clockwise<br>1 : clockwise | LSB |
| DP | All | 0 … 359.9999 | deg |
| WORKING RANGE | 17/32 pts | 65.5 … 360<br>32.75 … 180 | deg |
| WORK_RANGE_GAIN | All | x1 … x15.94 | - |
| LNRAX<br>LNRBX<br>LNRCX<br>LNRDX | 4 pts, X coordinates | 0 … 359.9999 | deg |
| LNRAY<br>LNRBY<br>LNRCY<br>LNRDY | 4 pts, Y coordinates | 0 … 100<br>-50 … + 150 | % |

| Parameter | LNR type | Value | Unit |
|---|---|---|---|
| LNRS0 <br> LNRAS <br> LNRBS <br> LNRCS <br> LNRDS | 4 pts, slopes | -17 … 0 … 17 | %/deg |
| LNRX0 <br> .. <br> LNRX7 | 8 pts, X coordinates | 0 … 359.9999 | deg |
| LNRY0 <br> … <br> LNRY7 <br> … <br> LNRY16 | 8,17 pts, Y coordinates | 0..100 <br> -50 … + 150 | % |
| LNR_DELTAY01 <br> … <br> LNR_DELTAY32 | 32 pts offsets | +/-3.125% <br> +/-6.25% <br> +/-12.5% <br> +/-25% | % |
| CLAMPLOW / CLAMPLOW2 | All | 0 … 100 | % |
| CLAMPHIGH / CLAMPHIGH2 | All | 0 … 100 | % |
| CLAMP2_EN | All | 0..1 | - |
| OUT2SLOPERATIO | All | -800% .. +800% | % |
| OUT2OFFSET | All | -400% .. +400% | % |

*Table 46 - Output linearization and clamping parameters*

## 12.2.1. Discontinuity Point (or Zero Degree Point)

The Discontinuity Point defines the 0° point on the circle. The discontinuity point places the origin at any location of the trigonometric circle. The DP is used as reference for all the angular measurements.
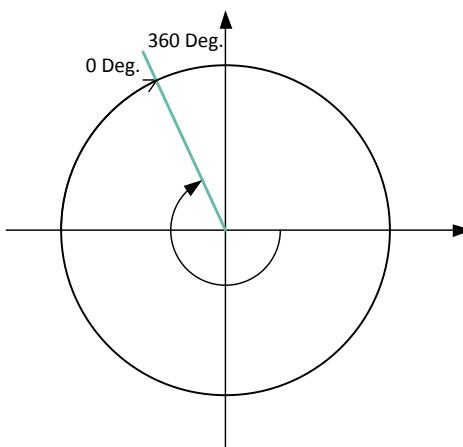


*fig. 19 - Discontinuity Point Positioning*

## 12.2.2. CW (Clockwise) Parameter

The CW parameter defines the magnet rotation direction.

- 0 or counter clockwise is the defined by the 1-4-5-8 pin order direction for the SOIC-8 package and 1 2 3 4 pin order direction for DMP-4 package.

- 1 or clockwise is defined by the reverse direction: 8-5-4-1 pin order direction for the SOIC-8 and 4 3 2 1 pin order direction for DMP-4 package.

Refer to the drawing in the sensitive spot positioning section (17.4, 17.9).

## 12.2.3. Filter

The MLX90374 Triaxis® position processor includes 2 types of filters:

- A low pass FIR Filter controlled by the FILTER parameter

- An exponential moving average (EMA) Filter: programmable by the HYST parameter

| Parameter | Value |
|-----------|-------|
| FILTER | 0 … 2 |
| HYST | 0 … 255 |

*Table 47 - Filter configuration*

### 12.2.3.1. FIR Filter

The MLX90374 features 2 FIR filter modes controlled with FILTER = 1…2. FILTER = 0 corresponds to no filtering. The transfer function is described by:

$$y_n = \frac{1}{\sum\limits_{i=0}^{j} a_i} \sum\limits_{i=0}^{j} a_i x_{n-i}$$

This filter characteristic is given in the Table 48.

| FILTER value | 0 | 1 | 2 |
|--------------|---|---|---|
| Type | Disabled | Finite Impulse Response | |
| Coefficients $a_i$ | 1 | 11 | 1111 |
| Title | No filter | ExtraLight | Light |
| DSP cycles (nb of taps) | 1 | 2 | 4 |
| Efficiency RMS (dB) | 0 | 3.0 | 6.0 |

*Table 48 - FIR Filter Characteristics*

## 12.2.3.2. Exponential Moving Average (IIR) Filter

The HYST parameter is a hysteresis threshold to activate / de-activate the exponential moving average filter. The output value of the IC is updated with the applied filter when the digital step is smaller than the programmed HYST parameter value. The output value is updated without applying the filter when the increment is bigger than the hysteresis. The filter reduces therefore the noise but still allows a fast step response for bigger angle changes. The hysteresis must be programmed to a value close to the internal magnetic angle noise level ($1LSB = 8 \cdot 360/2^{16}$).

$$y_n = a * x_n + (1-a) * y_{n-i} \qquad \begin{aligned} x_n &= Angle \\ y_n &= Output \end{aligned}$$

The filters characteristic is given in the following table (Table 49):

| DENOISING_FILTER_ALPHA_SEL | 0 | 1 | 2 | 3 |
|---|---|---|---|---|
| Coefficients a | 0.75 | 0.5 | 0.25 | 0.125 |
| Efficiency RMS (dB) | | 2.4 | 4.2 | |

*Table 49 - IIR Filter characteristics*

## 12.2.4. WORKING_RANGE Parameter for Angle Range Selection

The parameter WORKING_RANGE determines the input range on which the 16 or 32 segments are uniformly spread. This parameter is provided for compatibility with former versions of MLX Triaxis sensors. For full featured working range selection, see section 12.2.5. For WORKING_RANGE parameter (W), following table applies. Outside of the selected range, the output will remain at clamping levels.

| W | Range | Δx 17pts | Δx 32pts | W | Range | Δx 17pts | Δx 32pts |
|---|---|---|---|---|---|---|---|
| 0 | 180.0° | 11.3° | 5.6° | 8 | 90.0° | 5.6° | 2.8° |
| 1 | 160.0° | 10.0° | 5.0° | 9 | 72.0° | 4.5° | 2.3° |
| 2 | 144.0° | 9.0° | 4.5° | 10 | 60.0° | 3.8° | 1.9° |
| 3 | 131° | 8.2° | 4.1° | 11 | 51.45° | 3.2° | 1.6° |
| 4 | 120.0° | 7.5° | 3.8° | 12 | 45.0° | 2.8° | 1.4° |
| 5 | 221.5° | 6.9° | 3.5° | 13 | 40.0° | 2.5° | 1.3° |
| 6 | 103° | 6.4° | 3.2° | 14 | 36.0° | 2.3° | 1.1° |
| 7 | 96° | 6.0° | 3.0° | 15 | 32.75° | 2.0° | 1.0° |

*Table 50 - Working range for 180° periodicity (order code -100)*

| W | Range | Δx 17pts | Δx 32pts | W | Range | Δx 17pts | Δx 32pts |
|---|---|---|---|---|---|---|---|
| 0 | 360.0° | 22.5° | 11.3° | 8 | 180.0° | 11.3° | 5.6° |
| 1 | 320.0° | 20.0° | 10.0° | 9 | 144.0° | 9.0° | 4.5° |
| 2 | 288.0° | 18.0° | 9.0° | 10 | 120.0° | 7.5° | 3.8° |
| 3 | 261.8° | 16.4° | 8.2° | 11 | 102.9° | 6.4° | 3.2° |
| 4 | 240.0° | 15.0° | 7.5° | 12 | 90.0° | 5.6° | 2.8° |
| 5 | 221.5° | 13.8° | 6.9° | 13 | 80.0° | 5.0° | 2.5° |
| 6 | 205.7° | 12.9° | 6.4° | 14 | 72.0° | 4.5° | 2.3° |
| 7 | 192.0° | 12.0° | 6.0° | 15 | 65.5° | 4.1° | 2.0° |

*Table 51 - Working range for 360° periodicity (order code -200, -300)*

## 12.2.5. WORK_RANGE_GAIN Parameter for Angle Range Selection

Alternatively, the range for the angle can be selected using the WORK_RANGE_GAIN parameter, which applies a fixed gain to the transfer characteristic. When using WORK_RANGE_GAIN parameter, the anchor point is set in the middle of the full angular range, MaxRange/2, and the valid range is set symmetrically around this value based on the parameter value.

WORK_RANGE_GAIN is coded on 8 bits where the 4 MSB defines the integer part and the 4 LSB the fractional part. Therefore, the following equation applies to define the angle range w:

$$w = \frac{16 * \text{MaxRange}}{\text{WORK\_RANGE\_GAIN}}$$

MaxRange depends on the application. It is 360° for ordering codes -200 and -300 (linear stray-field immune and legacy) and 180° for ordering code -100 (rotary stray-field immune). Both minimal and maximal angles are then defined by :

$$\theta_{min} = \frac{MaxRange - w}{2} \; ; \; \theta_{max} = \frac{MaxRange + w}{2}$$

where $\theta_{min}$ corresponds to the angle giving an output of 0% and $\theta_{max}$ the angle giving an output of 100%. Following tables give some values as example. Outside of the working range, the output will remain at clamping levels.

| WORK_RANGE _GAIN | Zoom Factor | Range (w) | θmin | θmax | Δx 17pts | Δx 32pts |
|---|---|---|---|---|---|---|
| 0x10 | 1 | 180° | 0° | 180° | 11.25° | 5.63° |
| 0x20 | 2 | 90° | 45° | 135° | 5.63° | 2.81° |
| 0x40 | 4 | 45° | 67.5° | 112.5° | 2.81° | 1.41° |
| 0xFF | 15.94 | 11.3° | 78.7° | 101.3° | 0.71° | 0.35° |

*Table 52 - Working range defined by WORK_RANGE_GAIN parameter (ordering codes -100)*

| WORK_RANGE _GAIN | Zoom Factor | Range (w) | θmin | θmax | Δx 17pts | Δx 32pts |
|---|---|---|---|---|---|---|
| 0x10 | 1 | 360° | 0° | 360° | 22.5° | 11.3° |
| 0x20 | 2 | 180° | 90° | 270° | 11.3° | 5.6° |
| 0x40 | 4 | 90° | 135° | 225° | 5.6° | 2.8° |
| 0xFF | 15.94 | 22.6° | 168.7° | 191.3° | 1.41° | 0.71° |

*Table 53 - Working range defined by WORK_RANGE_GAIN parameter (ordering codes -200, -300)*

## 12.2.6. Piecewise Linear Transform

There are 4 different possibilities to define the transfer function (LNR). Configuration is specified in the Table 54.

- With 4 arbitrary points (defined by X and Y coordinates) and 5 slopes
- With 8 arbitrary points (defined by X and Y coordinates)
- With 17 equidistant points for which only the Y coordinates are defined
- With 32 equidistant points for which only offset of Y compared to the average value is defined

| Output Transfer Characteristic | 4POINTS | DSP_LNR_RESX2 |
|---|---|---|
| 4 Arbitrary Points | 1 | 0 |
| 8 Arbitrary Points | 1 | 1 |
| 17 Equidistant Points | 0 | 0 |
| 32 Equidistant Points | 0 | 1 |

*Table 54 - Output Transfer Characteristic Selection Table*

### 12.2.6.1. 4-Pts LNR Parameters

The LNR parameters, together with the clamping values, fully define the relation (the transfer function) between the digital angle and the output signal.

The shape of the MLX90374 four points transfer function from the digital angle value to the digital output is described in the following figure (fig. 20). Seven segments can be programmed but the clamping levels are necessarily flat. Two, three, or even six calibration points are then available, reducing the overall non-linearity of the IC by almost an order of magnitude each time. Three or six calibration point will be preferred by customers looking for excellent non-linearity figures. Two-point calibrations will be preferred by customers looking for a cheaper calibration set-up and shorter calibration time.
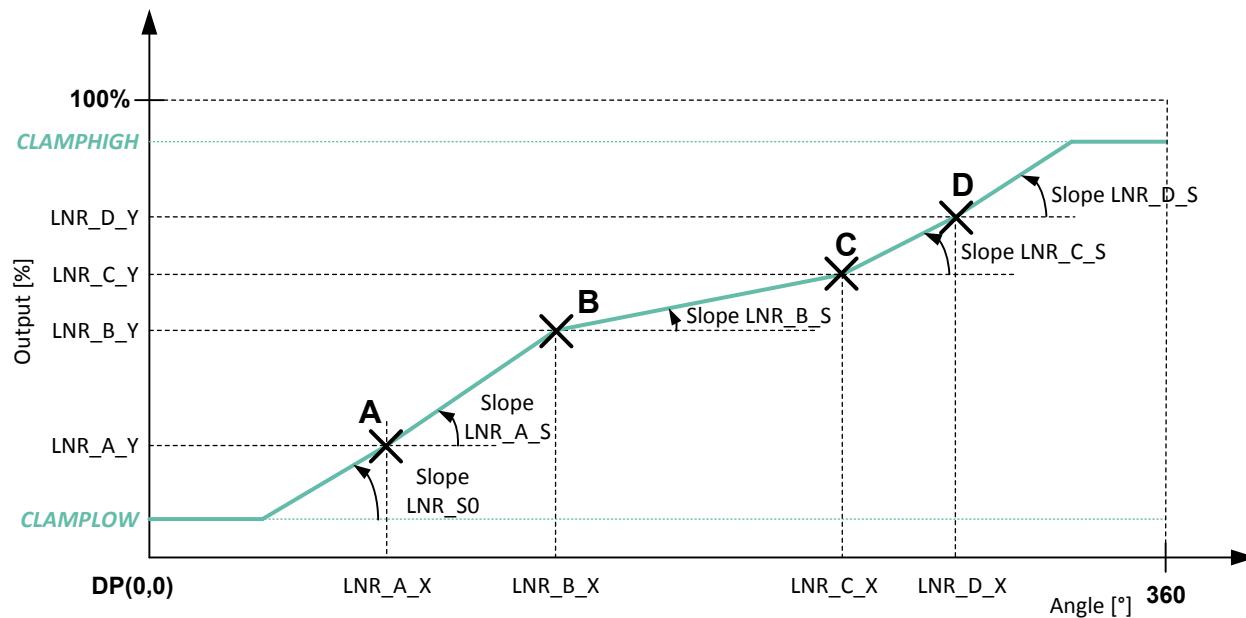
*fig. 20 - 4pts Linearisation Parameters Description*

### 12.2.6.2. 8-Pts LNR Parameters

The 8-Pts LNR parameters, together with the clamping values, fully define the relation (the transfer function) between the digital angle and the output signal.

The shape of the MLX90374 eight points transfer function from the digital angle value to the output voltage is described in the following figure (fig. 21). Eight calibration points [LNR_X0...7, LNR_Y0...7] together with 2 fixed points at the extremity of the range ([0°, 0%] ; [360°, 100%]) divides the transfer curve into 9 segments. Each segment is defined by 2 points and the values in between is calculated by linear interpolation.
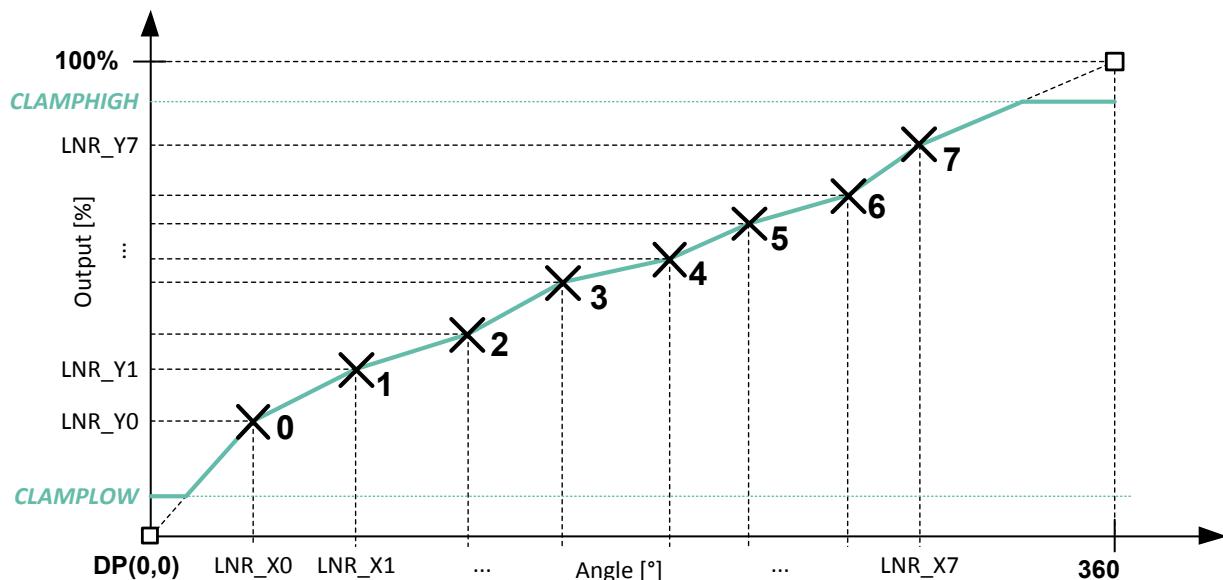


*fig. 21 - 8pts Linearisation Parameters Description*

### 12.2.6.3. 17-Pts LNR Parameters

The LNR parameters, together with the clamping values, fully define the relation (the transfer function) between the digital angle and the output signal.

The shape of the MLX90374 seventeen points transfer function from the digital angle value to the output voltage is described in the following figure (fig. 22). In the 17-Pts mode, the output transfer characteristic is Piece-Wise-Linear (PWL).
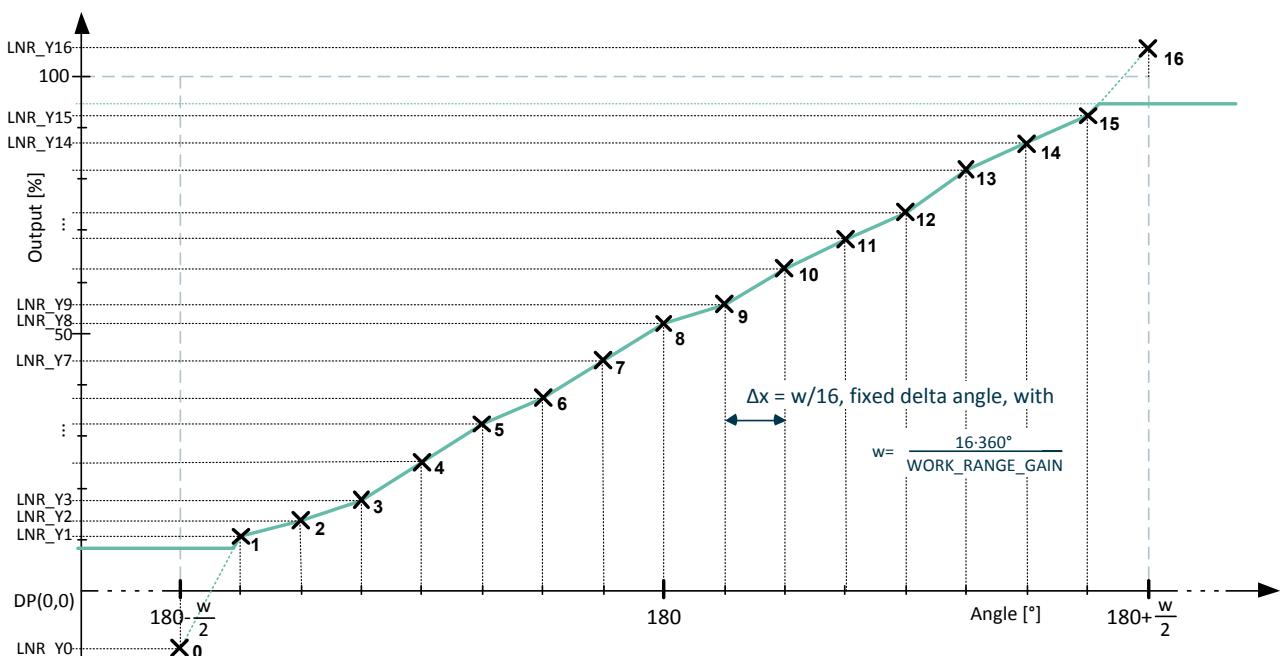


*fig. 22 - 17pts Linearisation Parameters Description*

All the Y-coordinates can be programmed from -50% up to +150% to allow clamping in the middle of one segment (like on the figure), but the output value is limited to CLAMPLOW and CLAMPHIGH values. Between two consecutive points, the output characteristic is interpolated.

### 12.2.6.4. 32-Pts LNR parameters

The LNR parameters, together with the clamping values, fully define the relation (the transfer function) between the digital angle and the output signal.

The shape of the MLX90374 thirty-two points transfer function from the digital angle value to the output voltage is described in the following figure (fig. 23). In the 32-Pts mode, the output transfer characteristic is Piece-Wise-Linear (PWL).

The points are spread evenly across the working range (see. 12.2.4 and 12.2.5 for working range selection). The Y-coordinates can be offset from the ideal characteristic within an adjustable range defined by LNR_DELTA_Y_EXPAND_LOG2. The available values are summarized in Table 55. All LNR_delta_Y## parameters are encoded in a fractional signed 8-bit value.
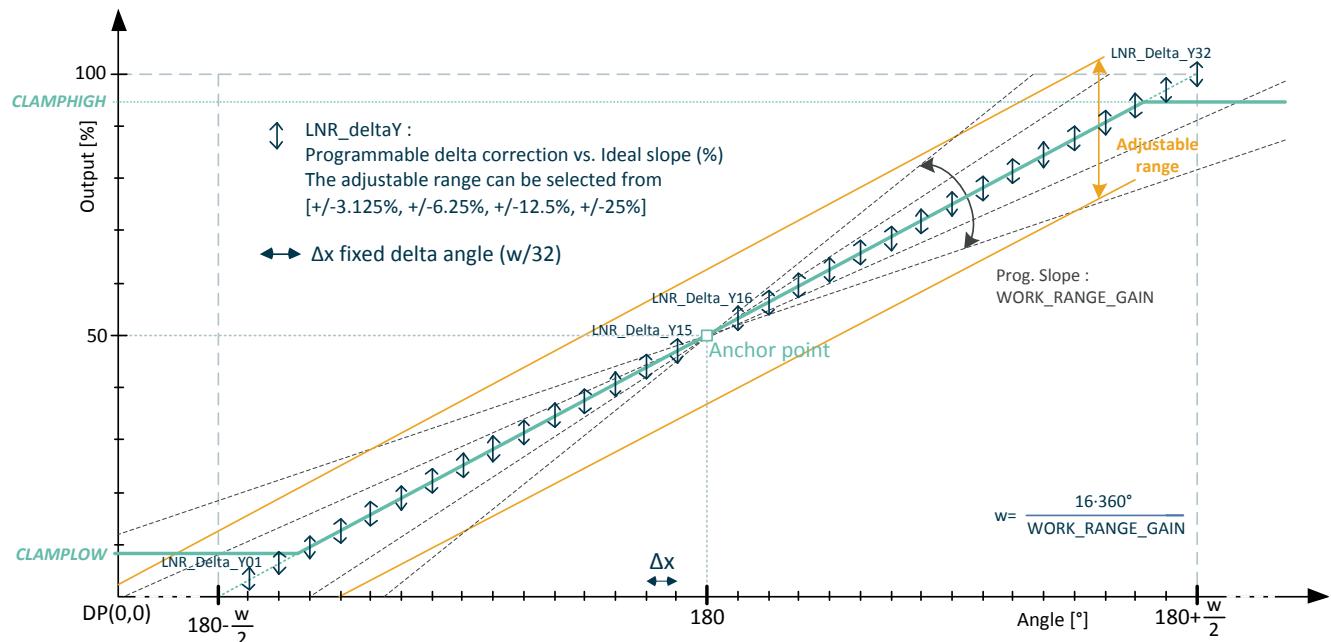
*fig. 23 - 32pts Linearisation Parameters Description*

| LNR_DELTA_Y_EXPAND_LOG2 | Adjustable Range | Correction resolution |
|:---:|:---:|:---:|
| 0 | ±3.125% | 0.024% |
| 1 | ±6.25% | 0.049% |
| 2 | ±12.5% | 0.098% |
| 3 | ±25% | 0.20% |

*Table 55 - LRN_DELTA_Y_EXPAND_LOG2 values and correction resolution*

## 12.2.7. Scaling Parameter

When enabled, this parameter doubles the scale of Y coordinates linearisation parameters from [0 .. 100]% to [-50 .. 150]% according to the following table (Table 56). This is valid for all linearisation schemes except the 32 points.

| USEROPTION_SCALING | LNR_Y min value | LNR_Y max value |
|:---:|:---:|:---:|
| 0 | 0% | 100% |
| 1 | -50% | 150% |

*Table 56 - USEROPTION_SCALING parameter*

## 12.2.8. Thermal offset correction- OUTSLOPE

Two parameters, OUTSLOPE_HOT and OUTSLOPE_COLD, are used to add a temperature dependent offset. This feature is enabled by the parameter OUTSLOPE_SEL that apply this modification either directly to the angle or after the linearisation and scaling functions. This thermal offset is only available with the revision ABC of the MLX90374. The MLX90374 Triaxis® position processor uses its internal linearized temperature to compute the offset shift as depicted in the figure below (fig. 24)
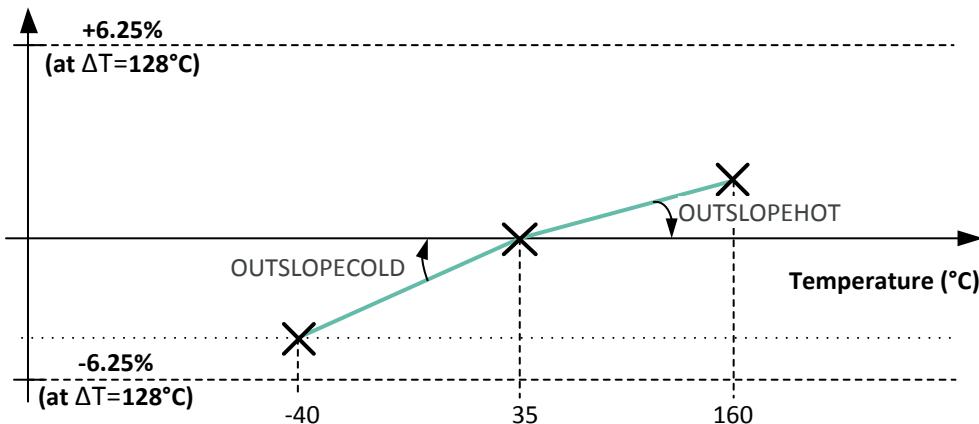
*fig. 24 - Temperature compensated offset*

The thermal offset can be added or subtracted before the clamping, either to the angle or output. The span of this offset is ±6.25% of the full output scale for a temperature difference of 128°C. The added thermal offset varies with temperature following the equations below. The two thermal coefficients are encoded in signed two's complement 8bit format (-128..127) and defined separately below 35°C (OUTSLOPE_COLD) and above 35°C (OUTSLOPE_HOT).

| OUTSLOPE_SEL | Description |
|---|---|
| 0 | No thermal offset correction |
| 1 | Thermal offset enabled, applied after angle calculation, i.e. after discontinuity point ($\theta_{r2p}$) |
| 2 | Thermal offset enabled, applied after output calculation and before clamping ($\theta_{out}$) |

*Table 57 - Temperature compensated offset selection parameter*

If IC internal temperature is higher than 35°C then:

$$\theta_{Tcomp} = \theta_{in}(1 - \Delta T \cdot \text{OUTSLOPE\_HOT})$$

If IC internal temperature is lower than 35°C then:

$$\theta_{Tcomp} = \theta_{in}(1 - \Delta T \cdot \text{OUTSLOPE\_COLD})$$

where $\theta_{in}$ is either $\theta_{r2p}$ or $\theta_{out}$ depending on OUSLOPE_SEL value.

## 12.2.9. Second Output Gain and Offset Parameters

The MLX90374 ABC revision offers the possibility to program a second output transfer characteristic. $OUT_2$ can be linearly transposed from OUT1 with the following relationship and parameters:

$$OUT_2 = OUT2OFFSET + OUT2SLOPERATIO * OUT_1$$

Both parameters are encoded on 16bits in two's complement with the range defined in Table 46 - Output linearization and clamping parameters.

## 12.2.10. CLAMPING Parameters

The clamping levels are two independent values to limit the output voltage range. The CLAMPLOW parameter adjusts the minimum output level. The CLAMPHIGH parameter sets the maximum output. Both parameters have 16 bits of adjustment and are available for all four LNR modes. As output data resolution is limited to 12bits, both in SENT and in PWM, the 4 LSB of this parameter will have no significant effect on the output. The value is encoded in fractional code, from 0% to 100%

On the MLX90374 ABC revision, the second output $OUT_2$ can use different clamping values when CLAMP2_EN is set. These parameters are names CLAMPLOW2 and CLAMPHIGH2 and use the same encoding than CLAMPHIGH and CLAMPLOW.

## 12.3. Selection of Output modes

This section describes the option to connect the DSP output signals to the physical IOs of the MLX90374 through the two possible output protocols, PWM and SENT. The following picture displays the possibilities offered by the MLX90374 Triaxis® processor. Some features are only available with the ABC revision of the device. Refer to the corresponding sections for more details.
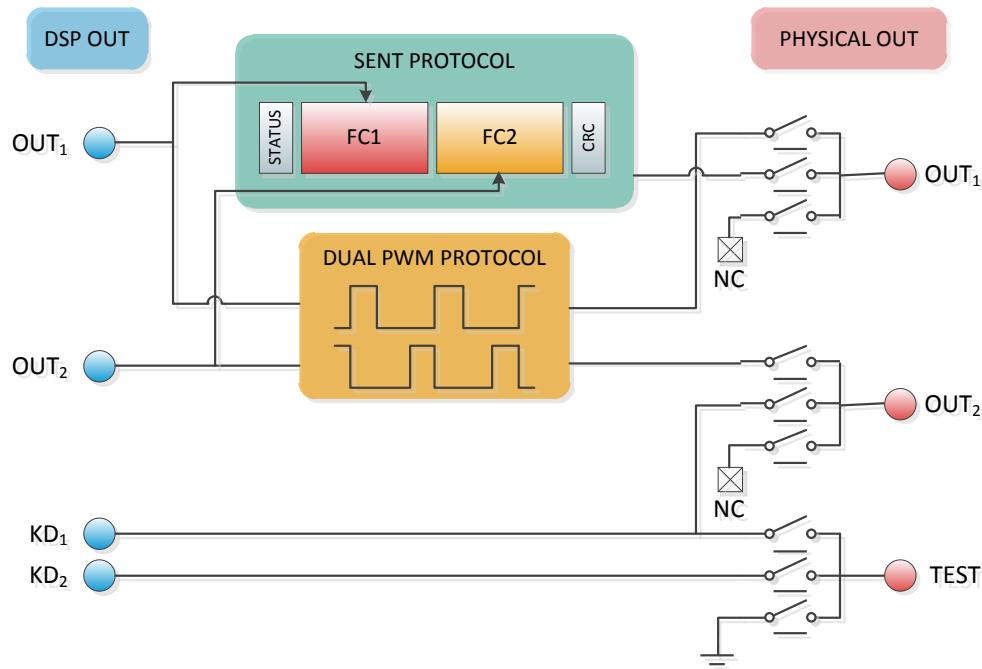


*fig. 25 – Output Protocols selection and connection matrix*

## 12.3.1. Digital Output Protocol (PROTOCOL)

Selection of the output protocol and the corresponding timing mode.

| PROTOCOL | Type | Descriptions |
|:---:|:---:|:---|
| 0 | SENT | Continuous asynchronous angle acquisition, SENT without pause pulse |
| 1 | PWM | Continuous asynchronous angle acquisition, PWM protocol |
| 2 | SENT | Continuous synchronous angle acquisition, SENT with pause |

*Table 58 - Protocol Selection*

## 12.3.2. PWM Output Polarity and Frequency

If PWM output mode is selected, the output signal is a digital signal with Pulse Width Modulation (PWM). The PWM polarity is selected by the PWM_POL parameter:

- PWM_POL = 0 for a low level at 100%
- PWM_POL = 1 for a high level at 100%

The PWM frequency is selected in the range [100, 2000] Hz by the T_FRAME parameter (12bits), defining the period time in the range [0.5; 10] ms. Minimum allowed value for T_FRAME is therefore 125 (0x7d).

$$T_{PWM} = \frac{4}{10^6} \times T\_FRAME$$

- PWM period is subject to the same tolerances as the main clock (see $\Delta T_{ck}$).

## 12.3.3. PWM Redundant Output

A second PWM output ($OUT_2$) can be enabled with the parameter PWM2_EN = 1 with the primary target to provide a redundant version of the PWM primary output ($OUT_1$). Without further modification and once enabled, the $OUT_2$ duty cycle is by default equal to:

$$DC_{OUT2} (\%) = 100\% - DC_{OUT1} (\%)$$

## 12.3.4. Dual PWM fault Reporting Mode

The ABC revision of the MLX90374 offers the possibility to select the fault reporting mode in dual PWM mode. In presence of a fault, the circuit will issue a signal with a duty cycle corresponding to the detected analog fault (see Table 42, PWM_DC_FAULT, PWM_DC_FIELDTOOLOW, PWM_DC_WEAKMAG). With the help of PWM_OUT_MODE, the user can select between redundant signals in the fault band or to keep either the angle information on $OUT_1$ or $OUT_2$.

## 12.3.5. OUT mode (ABE_OUT_MODE)

ABE_OUT_MODE defines the Output Stage physical mode used in application for both $OUT_1$ and $OUT_2$.

| ABE_OUT_MODE | Type | Description | Comments |
|:---:|:---|:---|:---|
| 0 | SENT | Push-Pull | |
| 1 | SENT | Open Drain | requires a pull-up resistor |
| 2 | PWM | Push-Pull | |
| 3 | PWM | Open Drain | requires a pull-up resistor |

*Table 59 - Output Mode Selection*

## 12.3.6. SENT Serial Channel Configuration- Status and Communication Nibble

| SERIAL_CONFIG | Type | Descriptions |
|:---:|:---:|:---|
| 0 | - | Status and Communication nibble is not present. This configuration is not compliant with SENT. **Do Not Use!** |
| 1 | nsp | Status nibble will report an error. Data sent along the serial channel is taken from RAM. |
| 2 | ssp | This short serial protocol is not compliant with SENT. **Do Not Use!** |
| 3 | esp | Status nibble reports errors and serial channel reports sequence defined in 10.2.7 |

*Table 60 - SENT Serial channel Configuration*

## 12.3.7. Switch Function (Kickdown)

The MLX90374 Triaxis position processor offers up to two switch functions with programmable polarity, threshold and hysteresis. The configuration of the kickdown outputs are defined in following table.

| KICKDOWN_EN | Switch configuration (ABB) | Switch configuration (ABC) |
|:---:|:---|:---|
| 0 | Kickdown disabled | Kickdown disabled |
| 1 | Enabled on $OUT_2$ | $KD_1$ enabled on TEST output |
| 2 | Not Available on ABB revision | $KD_1$ enabled on $OUT_2$ |
| 3 | Not Available on ABB revision | $KD_1$ enabled on $OUT_2$ and $KD_2$ enabled on TEST output |

*Table 61 – Switch Function Selection (Kickdown)*

The switch behaviour is defined by the three parameters listed in Table 62. The switch function is compared to the angle before any gain function applies (see fig. 18 – MLX90374 Digital Signal Processing Flow). Therefore, the full scale (100%) corresponds to the full magnetic range of the sensor (see 12.2.4 and 12.2.5).

| PARAMETER | Description | Comment |
|---|---|---|
| KICKDOWN_POL | Select switch(es) polarity | 0: Normal polarity (KD=1 if input>threshold)<br>1: Inverted polarity (KD=1 if input<threshold) |
| KICKDOWN_THRES_UP | Threshold for switch activation | 0-100% on 12bits |
| KICKDOWN_THRES_HYST | Hysteresis for switch return point | **ABB revision :**<br>0 - 4.7% on 2bits with 1.56% steps<br>**ABC revision :**<br>0 - 0.3% on 2bits with 0.1% steps |
| KICKDOWN_THRES_UP2 | Threshold for second switch activation | Similar to KICKDOWN_THRES_UP |
| KICKDOWN_THRES_HYST2 | Hysteresis for second switch return point | Similar to KICKDOWN_THRES_HYST |

*Table 62 – Switch Function Configuration (Kickdown)*

## 12.4. Programmable Diagnostics Settings

### 12.4.1. Diagnostics Global Enable

DIAG_EN should be kept to its default value (1) to retain all functional safety capabilities of the MLX90374. This feature shall not be disabled.

### 12.4.2. Diagnostic Debouncer

A debouncing algorithm is available for analog diagnostic reporting (see chapter 13, Functional Safety). This debouncer is disabled by default. Enabling it increases the reporting time of the device. Therefore, Melexis recommends keeping the debouncing of analog faults off by not modifying debouncer default values (see Table 42 for factory default values).

| NVRAM Parameter | Description |
|---|---|
| DIAGDEBOUNCE_STEPDOWN | Decrement values for debouncer counter |
| DIAGDEBOUNCE_STEPUP | Increment value for debouncer counter |
| DIAG_DEBOUNCE_THRESH | Threshold for debouncer counter to enter diagnostic mode |

*Table 63 - Diagnostic debouncing parameters*

Once an analog monitor detects an error, it takes control of the debouncing counter. This counter will be incremented by STEPUP value each time this specific monitor is evaluated, and the error is still present. When the debouncing counter reaches the value defined by DEBOUNCE THRESHOLD, an error is reported on the error channel, and the debouncing counter stays clamped to this DEBOUNCE THRESHOLD value (see 10.2.8 for SENT error message codes, 12.4.4 for PWM error reporting). Once the error disappears, each time its monitor is evaluated, the debouncing counter is decremented by STEPDOWN value. When the debouncing counter reaches zero, the error disappears from the reporting channel and the debouncing counter is released. To implement proper reporting times, one should refer to the DCT defined in theTable 9. The reporting and recovery time are defined in the table below (valid for THRESH≠0).

| Parameter | Min | Max |
|-----------|-----|-----|
| Reporting Time | $DCT \cdot \left( \left\lceil \dfrac{THRESH}{STEPUP} \right\rceil - 1 \right)$ | $DCT \cdot \left( \left\lceil \dfrac{THRESH}{STEPUP} \right\rceil \right)$ |
| Recovery Time | $DCT \cdot \left( \left\lceil \dfrac{THRESH}{STEPDOWN} \right\rceil \right)$ | $DCT \cdot \left( \left\lceil \dfrac{THRESH}{STEPDOWN} \right\rceil + 1 \right)$ |
| | $\left\lceil \dfrac{x}{y} \right\rceil$ | is the ceiling function of x divided by y |

*Table 64 - Diagnostic Reporting and Recovery times*

## 12.4.3. Over/Under Temperature Diagnostic

DIAG_TEMP_THR_HIGH defines the threshold for over temperature detection and is compared to the linearized value of the temperature sensor $T_{LIN}$

DIAG_TEMP_THR_LOW defines the threshold for under temperature detection and is compared to the linearized value of the temperature sensor $T_{LIN}$

$T_{LIN}$ is encoded using the SENT standard for temperature sensor. One can get the physical temperature of the die using following formula:

$$T_{PHY}[°C] = \frac{T_{LIN}}{8} - 73.15$$

DIAG_TEMP_THR_LOW/HIGH are encoded on 8-bit unsigned values with the following relationship towards $T_{Lin}$

$$DIAG\_TEMP\_THR\_(LOW/HIGH) = \frac{T_{LIN}}{16}$$

Following table summarizes the characteristics of the linearized temperature sensor and the encoding of the temperature monitor thresholds.

| Parameter | Symbol | Min | Typ | Max | Unit | Condition |
|---|---|---|---|---|---|---|
| $T_{LIN}$ resolution | $Res_{TLIN}$ | - | 0.125 | - | °C/LSB | |
| $T_{LIN}$ refresh rate | $F_{S,TLIN}$ | - | 200 | - | Hz | |
| $T_{LIN}$ linearity error | $T_{LinErr}$ | -8 | - | 8 | °C | from -40 to 160°C |
| High temperature threshold | DIAG_TEMP _THR_HIGH | - | 8 | - | LSB | Recommended value, corresponds to -57°C |
| Low temperature threshold | DIAG_TEMP _THR_LOW | - | 136 | - | LSB | Recommended value, corresponds to 199°C |
| High/low temperature threshold resolution | $Res_{Tthr}$ | | 2 | | °C/LSB | |

*Table 65 - Linearized Temperature Sensor characteristics*

## 12.4.4. PWM Diagnostic

In presence of an analog fault and when PWM_REPORT_MODE_ANA = 1, the PWM signal output a duty cycle in the fault band defined by the following configuration items.

PWM_DC_FAULT

PWM_DC_FIELDTOOLOW

PWM_DC_WEAKMAG

PWM_DC_FAULT

This parameter defines the duty-cycle that is present on PWM output in presence of an analog fault. This duty cycle shall be used for  generic diagnostic reporting.

WEAKMAGNET

This parameter defines the threshold on the field strength which determines the weak magnet condition; when PWM_DC_WEAKMAG = 0, there is no reporting of weak magnet condition. The encoding is similar than the encoding of FieldTooLow (see tables of chapter 7, Magnetic Field Specifications)

PWM_DC_WEAKMAG

This parameter defines the output duty-cycle in case of Weak Magnet, from 0% till 100% by steps of (100/256)%

PWM_DC_FIELDTOOLOW

This parameter defines the duty-cycle that is output in case of Field Too Low; the Field Too Low Diagnostic prevails over the Weak Magnet Diagnostic. Encoding of the duty cycle is from 0% till 100 % by steps of (100/256)%

# 13. Functional Safety

## 13.1. Safety Manual

The safety manual, available upon request, contains the necessary information to integrate the MLX90374 component in a safety related item, as Safety Element Out-of-Context (SEooC).

In particular it includes:

- The description of the Product Development lifecycle tailored for the Safety Element.
- An extract of the Technical Safety concept.
- The description of Assumptions-of-Use (AoU) of the element with respect to its intended use, including:
  - assumption on the device safe state;
  - assumptions on fault tolerant time interval and multiple-point faults detection interval;
  - assumptions on the context, including its external interfaces;
- The description of safety analysis results at the device level useful for the system integrator; HW architectural metrics and description of dependent failures initiators.
- The description and the result of the functional safety assessment process; list of confirmation measures and description of the independency level.

## 13.2. Safety Mechanisms

The MLX90374 provides numerous self-diagnostic features (safety mechanisms). Those features increase the robustness of the IC functionality by either preventing the IC to provide an erroneous output signal or reporting the failure according to the SENT protocol definition.

| Legend |
| :---: |
| ● High coverage |
| O Medium coverage |
| ANA : Analog hardware failure reporting, described in the safety manual |
| High-Z : Special reporting, output is set in high impedance mode (no HW fail-safe mode/timeout, no SW safe startup) |
| DIG : Digital hardware failure reporting, described in the safety manual |
| * : Diagnostic Cycle Time (see 6.1 for values) |
| At Startup : HW fault present at time zero is detected before a first frame is transmitted. |
| DIAG_EN : This safety mechanism can be disabled by setting DIAG_EN = 0 (see 11 End-User Programmable Items). This option should not be used in application mode! |

*Table 66 - Self Diagnostic Legend*

| Category and safety mechanism name | Front-end | ADC | DSP | Back-end | Sup port. Func. | Module & Package | DCT* | Reporting mode | At startup | DIAG EN |
|---|---|---|---|---|---|---|---|---|---|---|
| **Signal-conditioning (AFE, External Sensor) Diagnostic** | ● | ● | | | | ● | | ANA | | |
| Magnetic Signal Conditioning Voltage Test Pattern | ● | ○ | ○ | | | | DCT_Ana | ANA | | ● |
| Magnetic Signal Conditioning Rough Offset Clipping check | ● | | ○ | | | | DCT_Ana | ANA | NO | ● |
| Magnetic Signal Conditioning Gain Monitor | ● | | ○ | | | ● | DCT_Ana | ANA | YES | ● |
| Magnetic Signal Conditioning Gain Clamping | ● | | ○ | | | ● | DCT_Ana | ANA | YES | |
| Mag. Sig. Cond. Failure control by the chopping technique | ● | | | | | | n/a | n/a | YES | |
| External Sensor Sig. Cond. Voltage Valid Range Check | ● | | | | | ● | DCT_Ana | ANA | YES | ○[40] |
| External Sensor Sig. Cond. Frequency Valid Range Check | ● | | | | | ● | DCT_Ana | ANA | YES | ● |
| A/D Converter Test Pattern | | ● | | | | | DCT_Ana | ANA | | ● |
| ADC Conversion errors & Overflow Errors | | ● | | | | | DCT_Ana | ANA | YES | ● |
| Flux Monitor (Specific to Rotary mode) | ● | ○ | | | | ● | DCT_Ana | ANA | YES | ● |
| **Digital-circuit Diagnostic** | | | ● | | | | | DIG | | |
| RAM Parity, 1 bit per 16 bits word, ISO D.2.5.2 | | | ● | | | | <10µs | DIG | YES | ● |
| ROM Parity, 1 bit per 16 bits word, ISO D.2.5.2 | | | ● | | | | <10µs | DIG | YES | ● |
| NVRAM 16 bits signature (run-time) ISO D.2.4.3 | | | ● | | | | DCT_dig | DIG | | |
| NVRAM Single Error Correction ECC | | | ● | | | | n/a | n/a | YES | |
| NVRAM Double Error Detection ECC | | | ● | | | | DCT_Dig | DIG | YES | |

---

[40] *This safety mechanism is disabled by default.*

| Category and safety mechanism name | Front-end | ADC | DSP | Back-end | Sup port. Func. | Module & Package | DCT* | Reporting mode | At startup | DIAG EN |
|---|---|---|---|---|---|---|---|---|---|---|
| Logical Monitoring of program sequence ISO D.2.9.3 via Watchdog "IWD" (cpu clock) ISO D2.9.2 | | | ● | | O | | Tiwd | DIG | | ● |
| Watchdog "AWD" (separate clock) ISO D2.9.1 | | | ● | | O | | Tawd | DIG | | |
| CPU Errors "Invalid Address", "Wrong opcode" | | | ● | | O | | <10µs | DIG | YES | |
| ADC Interface Checksum | | ● | | | | | DCT_Dig | DIG | NO | ● |
| DSP Test Pattern (atan2) | | | ● | | O | | DCT_Dig | DIG | | ● |
| Critical ports monitoring | | | ● | | | | DCT_Dig | DIG | NO | ● |
| **SENT H/W Interface Diagnostic** | | | | ● | | | | DIG | | |
| SENT parity check over Configuration registers | | | | ● | | | <10µs | DIG | NO | ● |
| SENT block: Protection against re-configuration at run-time | | | | ● | | | <10µs | DIG | NO | ● |
| SENT Frame Counter & Redundant Nibble | | | | ● | | | n/a | n/a | n/a | |
| **System-level diagnostic** | | | | | ● | ● | | ANA | | |
| Supply Voltage Monitors (all supply domains) except VS_OV & POR | | | | | ● | ● | DCT_Ana | ANA | NO | ● |
| External Supply Overvoltage Monitor VS_OV | | | | | ● | ● | 2.1ms[41] | High-Z | YES | |
| Digital Supply under-voltage monitor (Power-on reset) | | | | | ● | ● | <10µs[42] | High-Z | YES | |
| Supply Bias Current Monitor | | | | | ● | | DCT_Ana | ANA | | ● |

[41] *This DCT is valid for detection. The recovery time of this diagnostic is defined by DCT_Ana. The debouncer is not active for this diagnostic (12.4.2)*

[42] *After a detection of this diagnostic, the circuit performs a standard reset sequence. The recovery time of this diagnostic is consequently defined by the startup time (6.3.1).*

| Category and safety mechanism name | Front-end | ADC | DSP | Back-end | Sup port. Func. | Module & Package | DCT* | Reporting mode | At startup | DIAG EN |
|---|---|---|---|---|---|---|---|---|---|---|
| Overheating monitor | O | O | O | O | O | ● | DCT_Ana | ANA | YES | ● |
| **Warning/Reporting Mechanisms** | | | | | | | n/a | n/a | | |
| HW Error Controller | | | ● | ● | ● | | n/a | DIG | YES | |
| HW Fail-safe mode with timeout | | | ● | ● | ● | | n/a | DIG | YES | |
| Analog-type Error management | ● | ● | | | ● | | n/a | ANA | | |
| Safe start-up mode | | | ● | | ● | | n/a | DIG | n/a | |
| **Mechanisms executed at start-up only** | | | | | | | | | | |
| RAM March-C HW Test at start-up | | | ● | | ● | | n/a | DIG | YES | |

*Table 67 - MLX90374 List of Self Diagnostics with Characteristics*

# 14. Recommended Application Diagrams

## 14.1. Wiring with the MLX90374 in SOIC-8 Package
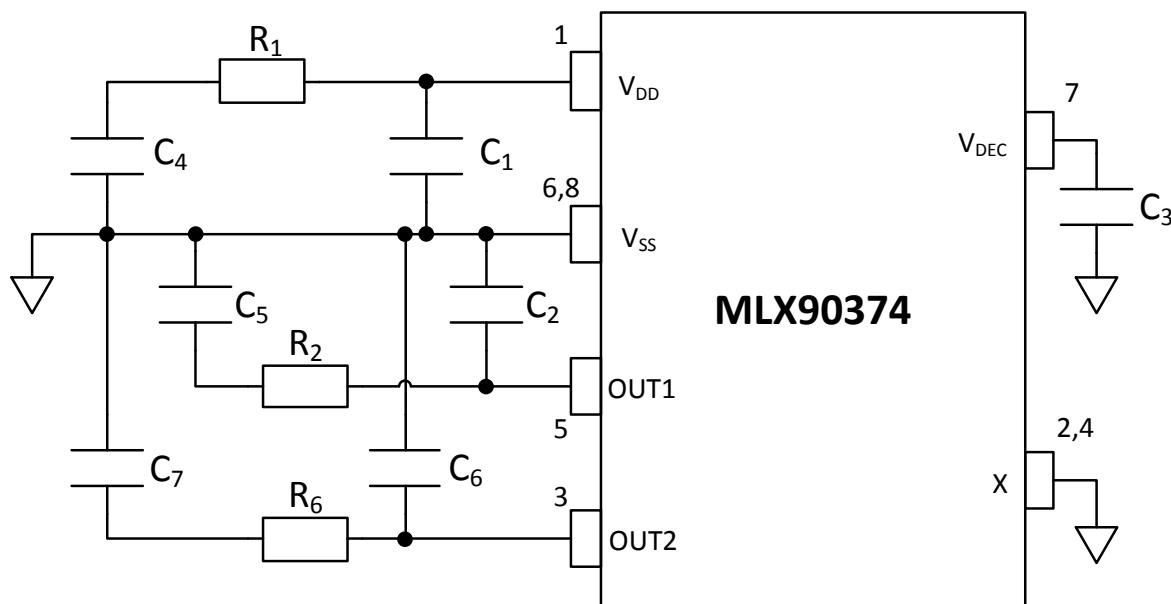


*fig. 26 - Recommended wiring for the MLX90374 in SOIC-8 package*

| Component | min | Typ | Max | Remark |
|---|---|---|---|---|
| $C_1$ | 100 nF | 220 nF | - | Close to the IC pin |
| $C_2, C_6$ ($C_L$) | - | 4.7nF<br>2.2nF | 10nF<br>4.7nF | normal SENT/PWM<br>fast SENT |
| $C_3$ | 47 nF | 100 nF | - | Close to the IC pin |
| $C_4$ | 0 | 1nF | - | Close to the connector |
| $C_5, C_7$ | 0 | 1nF | 15nF | Close to the connector |
| $R_1$ | 0 | 10 Ω | - | Recommended value |
| $R_2, R_6$ | 0 | 120 Ω | 220 Ω | Recommended value |

*Table 68 - Recommended Values for the MLX90374 in SOIC-8 Package*

## 14.2. Wiring with the MLX90374 in DMP-4 Package (built-in capacitors)
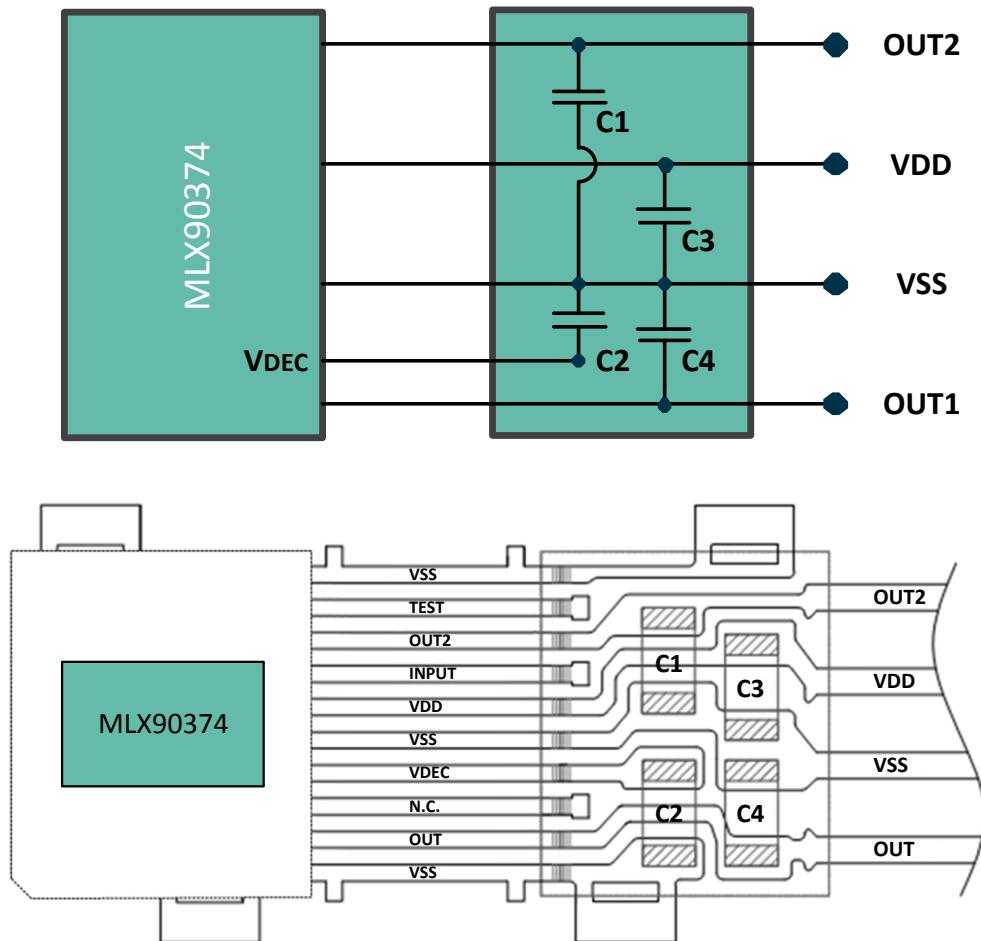


*fig. 27 - Internal wiring of the MLX90374 in DMP-4*

| Component | Value | Remark |
|---|---|---|
| C1,C4 | 10.0 nF | Ordering code -10x, -20x, -30x |
| C2 | 220 nF | Ordering code -10x, -20x, -30x |
| C3 | 100 nF | Ordering code -10x, -20x, -30x |

*Table 69 - DMP-4 capacitors configuration*

# 15. Standard information regarding manufacturability of Melexis products with different soldering processes

Our products are classified and qualified regarding soldering technology, solderability and moisture sensitivity level according to standards in place in Semiconductor industry.

For further details about test method references and for compliance verification of selected soldering method for product integration, Melexis recommends reviewing on our web site the General Guidelines soldering recommendation (http://www.melexis.com/en/quality-environment/soldering)

For all soldering technologies deviating from the one mentioned in above document (regarding peak temperature, temperature gradient, temperature profile etc), additional classification and qualification tests have to be agreed upon with Melexis.

For package technology embedding trim and form post-delivery capability, Melexis recommends consulting the dedicated trim & form recommendation application note : "Lead Trimming and Forming Recommendations" (https://www.melexis.com/en/documents/documentation/application-notes/application-note-lead-trimming-and-forming-recommendations).

Melexis is contributing to global environmental conservation by promoting lead free solutions. For more information on qualifications of RoHS compliant products (RoHS = European directive on the Restriction Of the use of certain Hazardous Substances) please visit the quality page on our website: http://www.melexis.com/en/quality-environment.

# 16. ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD).
Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

# 17. Package Information

## 17.1. SOIC-8- Package Dimensions

NOTES:

All dimensions are in millimeters (angles in degrees).
* Dimension does not include mold flash, protrusions or gate burrs (shall not exceed 0.15 per side).
** Dimension does not include interleads flash or protrusion (shall not exceed 0.25 per side).
*** Dimension does not include dambar protrusion. Allowable dambar protrusion shall be 0.08 mm total in excess of the dimension at maximum material condition. Dambar cannot be located on the lower radius of the foot.

*fig. 28 - SOIC-8 Package Outline Dimensions*

## 17.2. SOIC-8- Pinout and Marking

**Marking**

Part Number MLX90374 (3 digits)

Die version (3 digits)

374    Axx

**TOP**

F    xxxxx → Lot number (5 digits)

Fab Identifier (1 letter)

Xy    Z

Application code  (1 digits)

Post-Process info (2 digits)

**Bottom**    YYWW

Assembly Year (YY) and week (WW)

Pinout:
Vss (8) Vdec Vss OUT₁ (5)
374ABC
Fxxxxx
Xy - Z
VDD (1) Input OUT₂ Test (4)

Z code :
"S" : Sun (rotary stray field robust)
"D" : Dual disk (linear stray field robust)
"C" : Clover (standard/legacy mode)

*fig. 29 - SOIC-8 Pinout and Marking*

## 17.3. SOIC-8- Sensitive spot positioning

### 17.3.1. Rotary Stray-field Immune and Standard Mode Applications
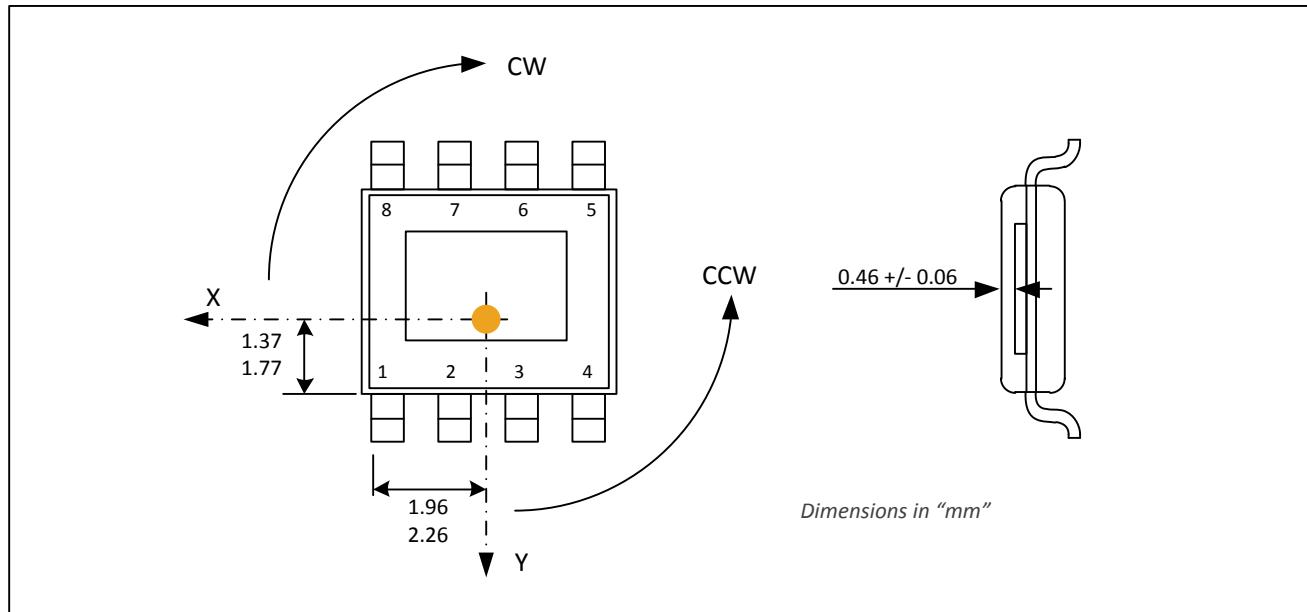


*fig. 30 - SOIC-8 Sensitive Spot Position*

### 17.3.2. Linear Stray-field Immune Applications
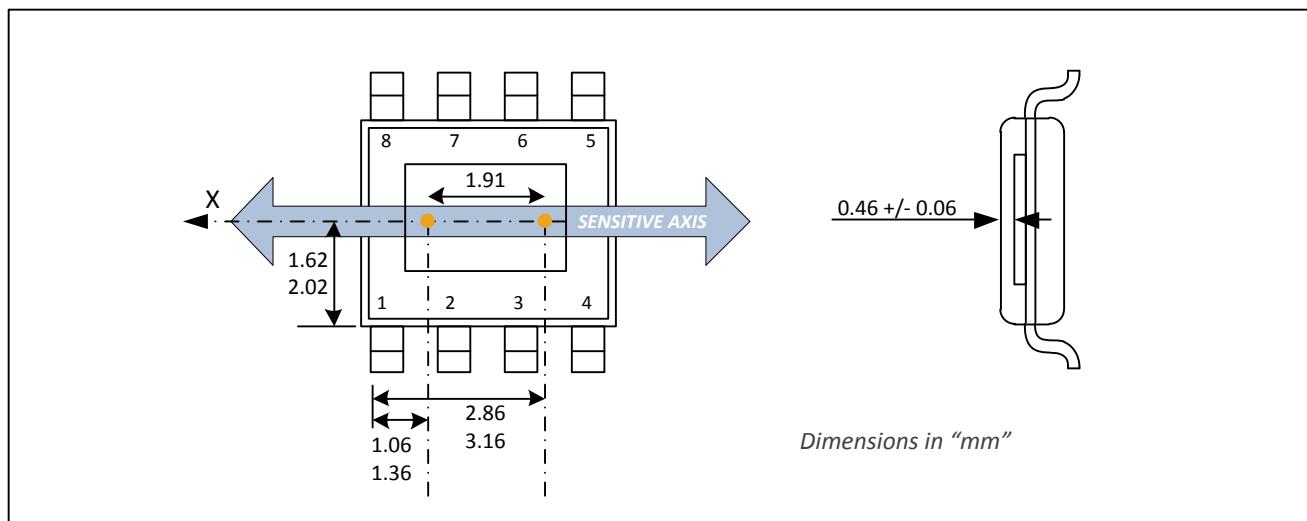


*fig. 31 - SOIC-8 Sensitive Spot position for Linear Stray-Field Immune*

## 17.4. SOIC-8- Angle detection
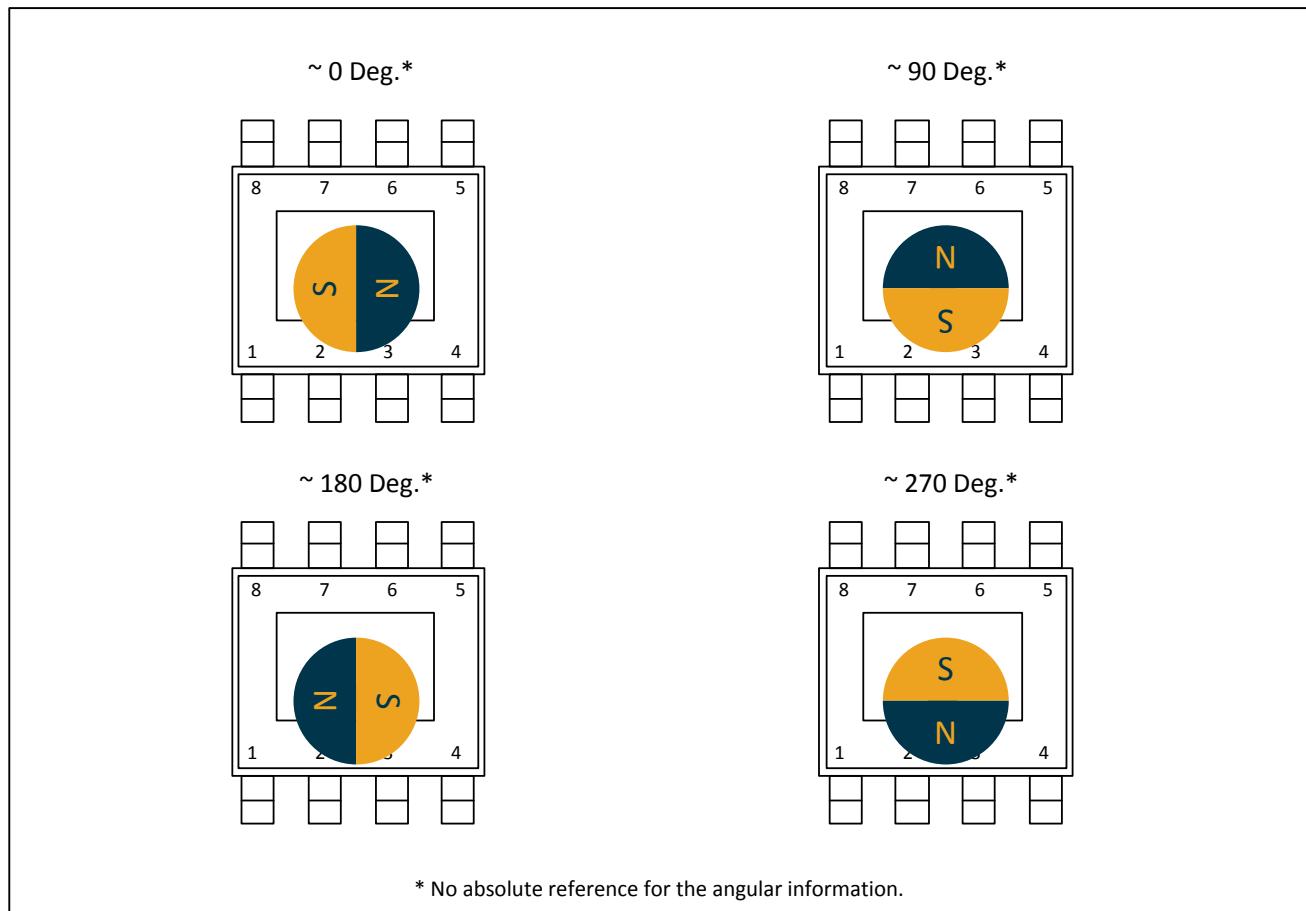


*fig. 32 - SOIC-8 Angle Detection*

The MLX90374 is an absolute angular position sensor but the linearity error (See section 8.1.1 ) does not include the error linked to the absolute reference 0 Deg (which can be fixed in the application through the discontinuity point).

## 17.5. DMP-4- Package Outline Dimensions (POD) STD1 1.27

| Rev. | Description | Date | Trigram |
|------|-------------|------|---------|
| 1.0 | Initial creation | 2011-06 | VLV |
| 2.0 | Template update | 2017-08-09 | EVA |



Notes:
1. All dimensions are in mm.
2. The values of the Magnetic Center positions Xc,Yc,Zc depend on the product type. See datasheet.
3. Lead plating: matted TIN, electroplated, 7.5-15.2$\mu$m thickness.
4. Dimensions do not include mold flash and lead surface finishing.
5. Dimensions in parenthesis (xx) are the result of molding (plastics) or stamping (leadframe).
   Tolerances on these dimensions are: angular $\pm 2°$; linear (plastics-plastics)$\pm 0.08$mm / (plastics-leadframe)$\pm 0.08$mm / (leadframe-leadframe)$\pm 0.05$mm.
6. Mold flash can occur at the locations where the mold reaches the leadframe but should not exceed 150$\mu$m.
7. This dimension is not inspected by optical measurement.
8. Dimension between lead frame elements and lead frame to mold don't include lead plating thickness.

| | | Name | Date | DMP STD1 1.27 |
|---|---|------|------|---------------|
| | Created | VLV | 2011-06 | |
| | Modified | EVA | 2017-08-09 | |
| | Approved | HHA / DFI | 2017-08-10 | Gen. tolerance: Lin.: $\pm 0.3$ mm, Ang.: $\pm 2°$ |
| File | dmp_STD1_1-27 | Scale | 5:1 | Sheet 1 of 1 | Rev. | 2.0 | A4 |

*fig. 33 - DMP-4 Straight Leads Package Outline Drawing*

## 17.6. DMP-4- Package Outline Dimensions (POD) STD3 2.00



Notes:
1. All dimensions are in mm.
2. The values of the Magnetic Center positions Xc,Yc,Zc depend on the product type. See datasheet.
3. Lead plating: matted TIN, electroplated, 7.5-15.2$\mu$m thickness.
4. Dimensions do not include mold flash and lead surface finishing.
5. Dimensions in parenthesis (xx) are the result of molding (plastics) or stamping (leadframe).
   Tolerances on these dimensions are: angular ±2°; linear (plastics-plastics)±0.08mm / (plastics-leadframe)±0.08mm / (leadframe-leadframe)±0.05mm.
6. Mold flash can occur at the locations where the mold reaches the leadframe but should not exceed 150$\mu$m.
7. This dimension is not inspected by optical measurement.
8. Dimension between lead frame elements and lead frame to mold don't include lead plating thickness.

| Rev. | Description | Date | Trigram |
|---|---|---|---|
| 1.0 | Initial creation | 2016-09-20 | VLV |
| 2.0 | Template update | 2017-08-23 | EVA |

|  | Name | Date | DMP STD3 2.00 |
|---|---|---|---|
| Created | VLV | 2016-09-20 | |
| Modified | EVA | 2017-08-23 | |
| Approved | HHA / DFI | 2017-11-29 | Gen. tolerance: Lin.: ±0.3 mm, Ang.: ±2° |

| File | dmp_std3_2-00 | Scale | 5:1 | Sheet 1 of 1 | Rev. | 2.0 | A4 |

*fig. 34 - DMP-4 STD3 2.00 Package Outline Drawing*

## 17.7. DMP-4- Marking
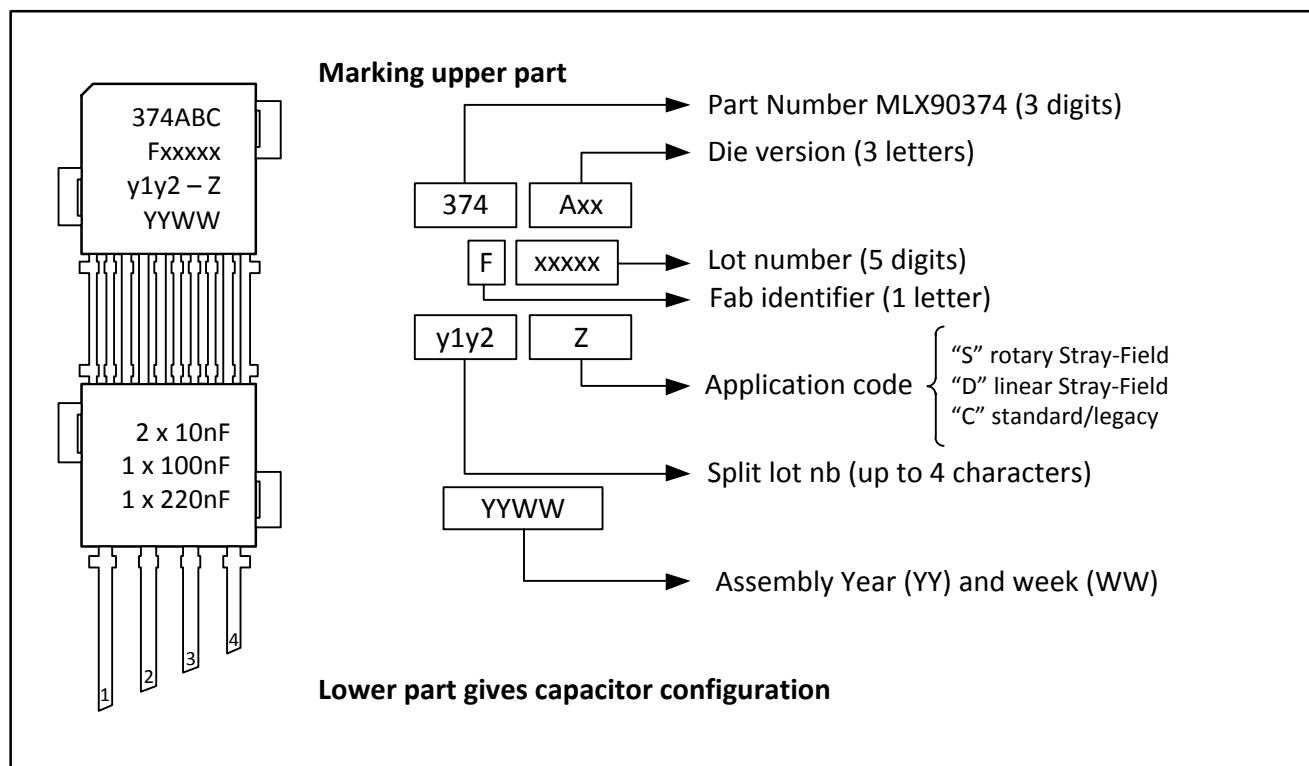


*fig. 35 - DMP-4 Marking*

## 17.8. DMP-4- Sensitive Spot Positioning

### 17.8.1. Rotary Stray-field Immune or Standard Mode Applications
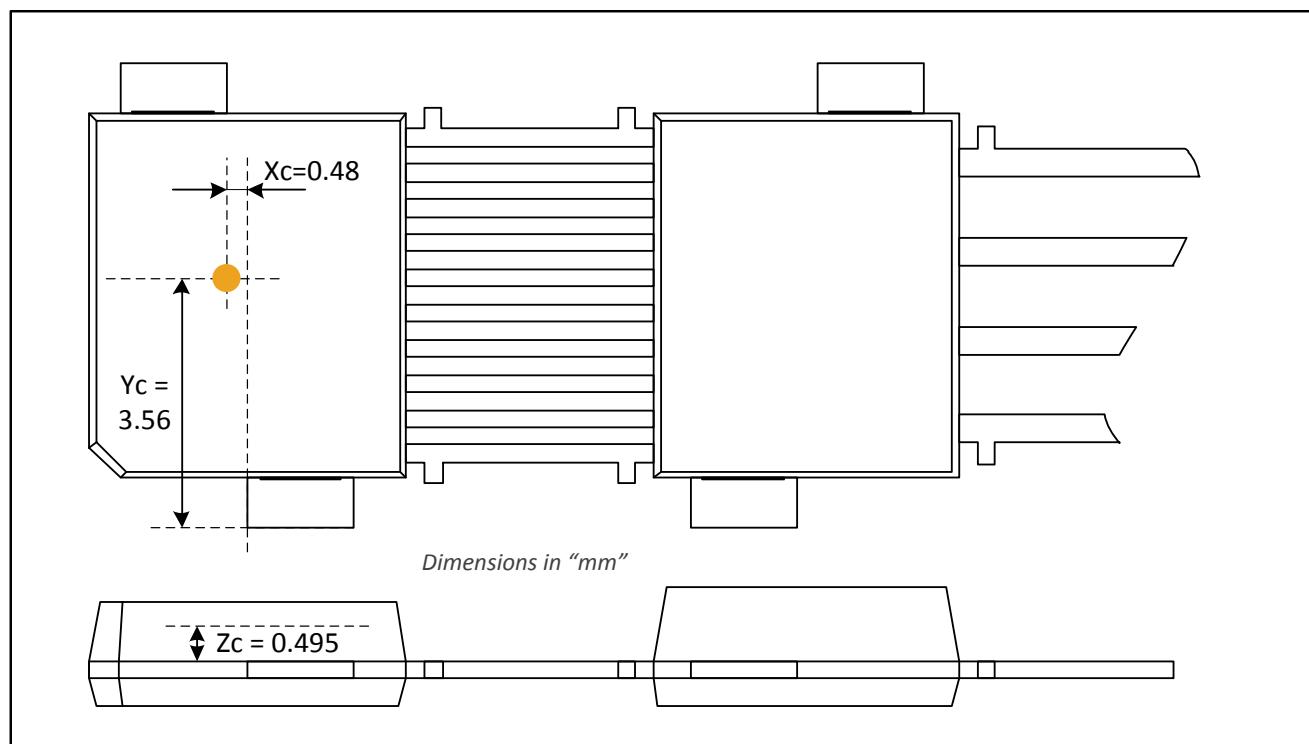


*fig. 36 - DMP-4 Rotary Stray-field or legacy Sensitive Spot Position*

## 17.8.2. Linear Stray-field Immune Applications
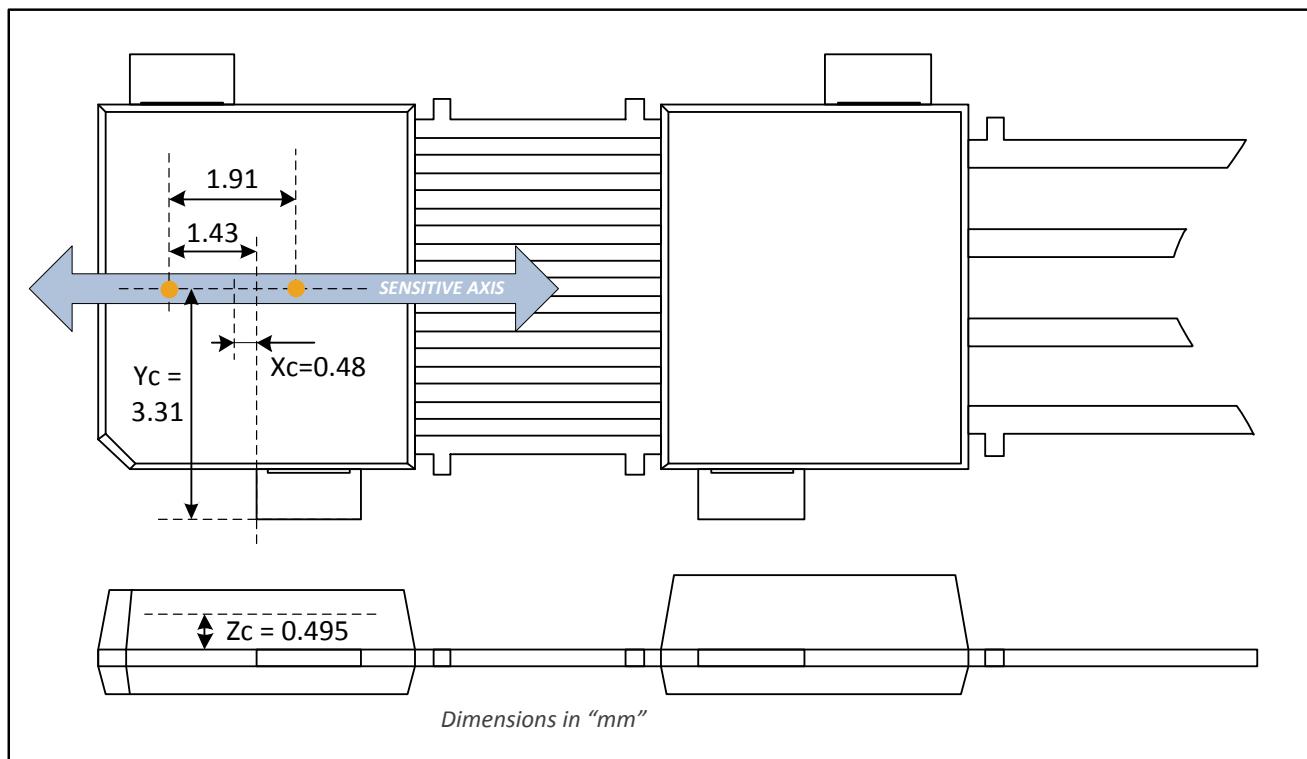


fig. 37 - DMP-4 Linear Stray-field Sensitive Spots Position

## 17.9. DMP-4- Angle detection
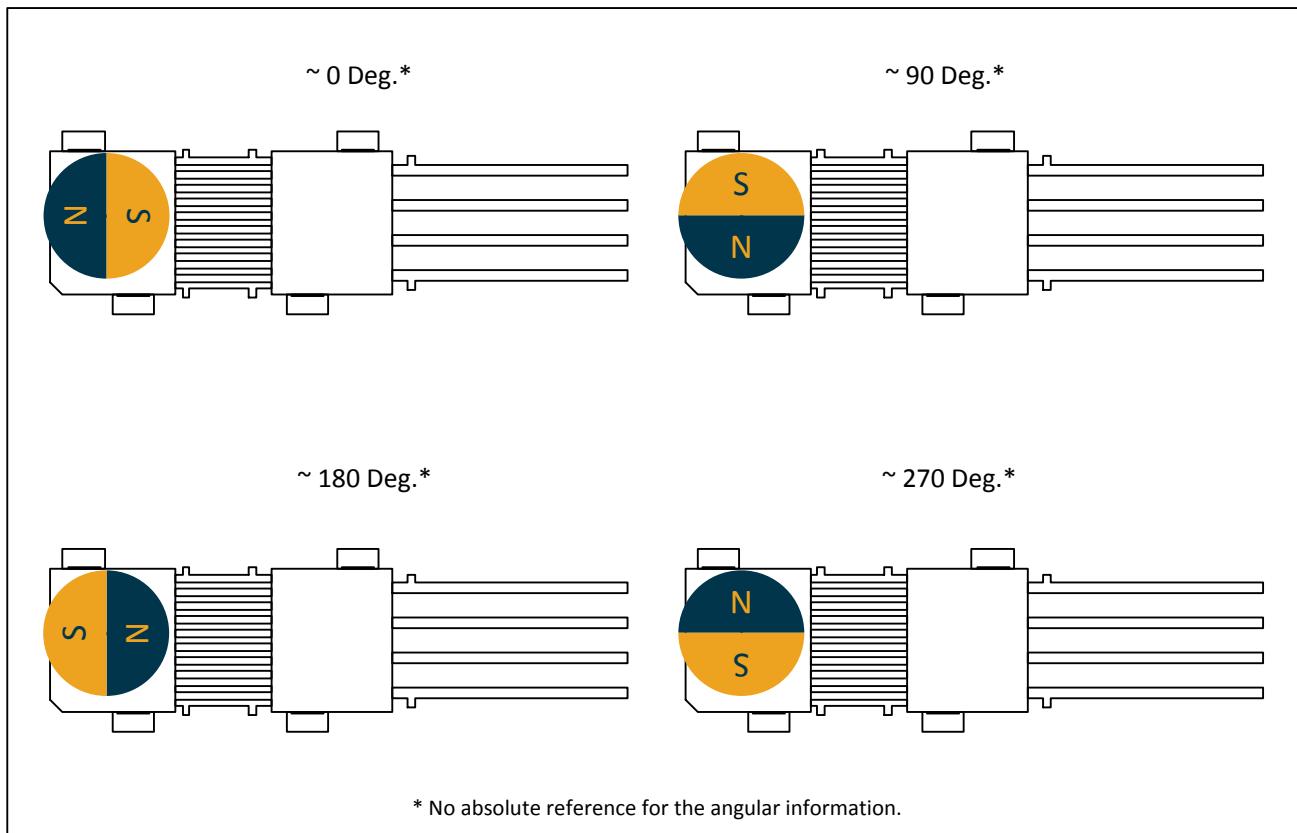


*fig. 38 - DMP-4 Angle Detection*

The MLX90374 is an absolute angular position sensor but the linearity error (See section 8.1.1 ) does not include the error linked to the absolute reference 0 Deg (which can be fixed in the application through the discontinuity point).

## 17.10. Packages Thermal Performances

The table below describe the thermal behaviour of available packages following JEDEC EIA/JESD 51.X standard.

| Package | Junction to case - θjc | Junction to ambient - θja (JEDEC 1s2p board) | Junction to ambient - θja (JEDEC 1s2p board) |
|---------|------------------------|-----------------------------------------------|-----------------------------------------------|
| SOIC-8  | 38.8 K/W               | 112 K/W                                       | 153 K/W                                       |
| DMP-4   | 32.2 K/W               | 88.7 K/W                                      | done without PCB [43]                         |

*Table 70 - Standard Packages Thermal Performances*

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[43] *DMP-4 as PCB-less solution has been evaluated in a typical application case. Values for this package are given as informative.*

# 18. Contact

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For additional information, please contact our Direct Sales team and get help for your specific needs:

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